

# Integrated PMIC with 4-Channel Synchronous Buck Converters, 8 LDOs, and MTP Non-Volatile Memory for Industrial and Automotive Applications

#### **General Description**

The RT5028F is a highly-integrated low-power highperformance analog SOC with PMIC in one single chip designed for industrial/automotive applications.

The RT5028F includes four synchronous step-down DC-DC converters and eight LDOs for system power.

The RT5028F also embeds one EEPROM (MTP) for setting sequence and timing etc.

Additionally, the RT5028F PMIC also includes one IRQ report.

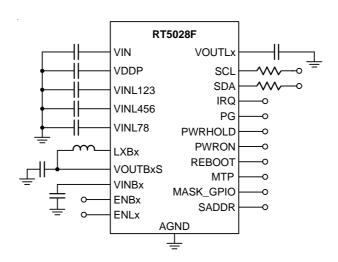
## **Applications**

Industrial/Automotive

#### **Features**

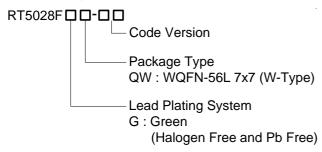
- Input Voltage Operating Range is 3.15V to 5.5V
- $\bullet$  Step-Down Regulator :  $V_{\text{IN}}$  Range is 3.15V to 5.5V
  - ▶ Max Current 2.4A/2A/1.6A/2A
  - ▶ Programmable Frequency from 500kHz to 2MHz
  - ▶ I<sup>2</sup>C Programmable Output Level
  - I<sup>2</sup>C Programmable Operation Mode (Force PWM or Auto PSM/PWM)
  - I<sup>2</sup>C Programmable Output Discharge Mode (Discharge or Floating)
- Linear Regulators: V<sub>IN</sub> Range is 2.5V to 5.5V
  - ▶ Max Current 0.3A
  - ▶ I<sup>2</sup>C Programmable Output Level
- Embedded 32Bytes MTP for Factory Tuning
- **▶ External MTP Pin for Write Protection**
- Sequence can be Controlled by I<sup>2</sup>C or each EN pins Defined by MASK\_GPIO Pin
- OT/UVP/VIN LV/POWRON Press Time Interrupt (IRQ)
  - ▶ I<sup>2</sup>C Control Interface : Support Fast Mode Up to 400kb/s
- RoHS Compliant and Halogen Free

## **Simplified Application Circuit**





## **Ordering Information**



#### Note:

Richtek products are:

- ▶ RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ▶ Suitable for use in SnPb or Pb-free soldering processes.

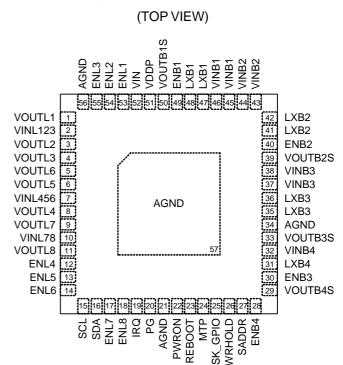
## **Marking Information**



RT5028FGQW: Product Number

YMDNN: Date Code

## **Pin Configuration**



WQFN-56L 7x7

## **Functional Pin Description**

Pin No.	Pin Name	Pin Function
1	VOUTL1	Output voltage regulation node for LDO1.
2	VINL123	Input power for LDO1, LDO2 and LDO3.
3	VOUTL2	Output voltage regulation node for LDO2.
4	VOUTL3	Output voltage regulation node for LDO3.
5	VOUTL6	Output voltage regulation node for LDO6.
6	VOUTL5	Output voltage regulation node for LDO5.
7	VINL456	Input power for LDO4, LDO5 and LDO6.
8	VOUTL4	Output voltage regulation node for LDO4.
9	VOUTL7	Output voltage regulation node for LDO7.
10	VINL78	Input power for LDO7 and LDO8.
11	VOUTL8	Output voltage regulation node for LDO8.
12	ENL4	Enable control input for LDO4.
13	ENL5	Enable control input for LDO5.
14	ENL6	Enable control input for LDO6.
15	SCL	Clock input for I <sup>2</sup> C. Open-drain output.

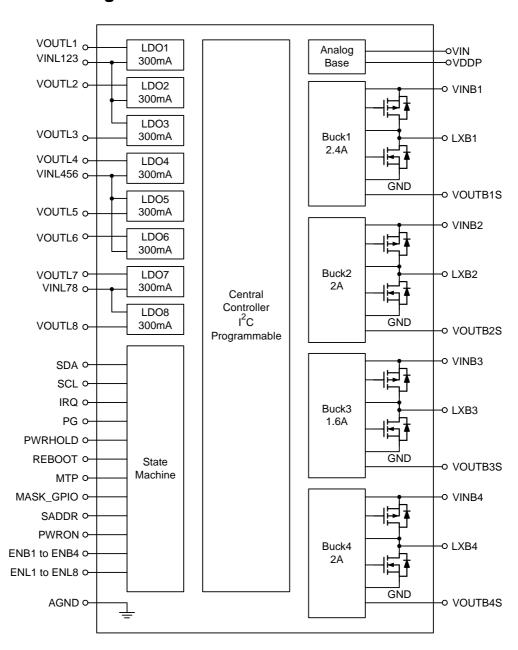
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Pin No.	Pin Name	Pin Function	
16	SDA	Data input for I <sup>2</sup> C. Open-drain output.	
17	ENL7	Enable control input for LDO7.	
18	ENL8	Enable control input for LDO8.	
19	IRQ	Open-drain IRQ output node.	
20	PG	Power good indicator.	
21, 34, 56, 57 (Exposed Pad)	AGND	Analog ground. The exposed pad must be soldered to a large PCB and connected to AGND for maximum power dissipation.	
22	PWRON	Manual power on.	
23	REBOOT	System power reboot.	
24	MTP	MTP write protection pin. Logic low is inhibited and logic high is permit to write.	
25	MASK_GPIO	Select $I^2C$ or EN pin for Bucks and LDOs. Connect a $100k\Omega$ pull-low resistor. As MASK_GPIO is high, ignore all EN pins. As MASK_GPIO is low, EN pins and $I^2C$ both can control. EN pins priority is higher than $I^2C$ .	
26	PWRHOLD	Power hold input.	
27	SADDR	I <sup>2</sup> C slave address.	
28	ENB4	Enable control input for Buck4.	
29	VOUTB4S	Output voltage regulation node for Buck4.	
30	ENB3	Enable control input for Buck3.	
31	LXB4	Internal switch node to output inductor connection for Buck4.	
32	VINB4	Input power for Buck4.	
33	VOUTB3S	Output voltage regulation node for Buck3.	
35, 36	LXB3	Internal switch node to output inductor connection for Buck3.	
37, 38	VINB3	Input power for Buck3.	
39	VOUTB2S	Output voltage regulation node for Buck2.	
40	ENB2	Enable control input for Buck2.	
41, 42	LXB2	Internal switch node to output inductor connection for Buck2.	
43, 44	VINB2	Input power for Buck2.	
45, 46	VINB1	Input power for Buck1.	
47, 48	LXB1	Internal switch node to output inductor connection for Buck1.	
49	ENB1	Enable control input for Buck1.	
50	VOUTB1S	Output voltage regulation node for Buck1	
51	VDDP	Internal bias regulator voltage. External load on this pin is not allowed.	
52	VIN	Input power for analog base.	
53	ENL1	Enable control input for LDO1.	
54	ENL2	Enable control input for LDO2.	
55	ENL3	Enable control input for LDO3.	



## **Functional Block Diagram**





## Absolute Maximum Ratings (Note 1)

Analog Base Input Voltage, VIN	-0.3V to 6V
• PMIC Input Voltage, VINL123/456/78, VINB1/2/3/4	-0.3V to 6V
PMIC Output Voltage, VOUTLx, VOUTBxS, LXBx	-0.3V to 6V
PMIC related Other Pins	-0.3V to 6V
<ul> <li>Power Dissipation, P<sub>D</sub> @ T<sub>A</sub> = 25°C</li> </ul>	
WQFN-56L 7x7	3.7W
Package Thermal Resistance (Note 2)	
WQFN-56L 7x7, $\theta_{JA}$	27°C/W
WQFN-56L 7x7, $\theta_{JC}$	7°C/W
• Junction Temperature	150°C
• Lead Temperature (Soldering, 10 sec.)	260°C
• Storage Temperature Range	$-65^{\circ}\text{C}$ to $150^{\circ}\text{C}$
ESD Susceptibility (Note 3)	
HBM (Human Body Model)	2kV

(Note 4)

• Junction Temperature Range ------ -40°C to 125°C
• Ambient Temperature Range ------ -40°C to 85°C

### **Electrical Characteristics**

**Recommended Operating Conditions** 

 $(T_A = 25^{\circ}C, V_{IN} = 3.15V \text{ to } 5.5V \text{ (Note 5, 6)})$ 

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
AMR for VIN					6	V
Operation Voltage of VIN		As fsw > 1MHz, $3.15V \le V_{IN} \le 5.5V$ . If $f_{SW} \le 1MHz$ , $V_{IN} \ge 4V$ .	3.15		5.5	V
PMIC						
0		$V_{IN}$ = 5V, LDOs, Bucks are ON with no load. Bucks operate in auto mode (Reg 0x06 = FFh)	350	700	950	- μΑ
Quiescent Current	lin	V <sub>IN</sub> = 5V, SCL = SDA = 0V, LDO and Bucks are OFF, Disable PMIC (Reg0x15[7] = 1)	5	30	60	
Warning for Die	OTW	Temperature 1		100		°C
Temperature	OTW	Temperature 2		125		-0
Over-Temperature Protection	ОТР			165		°C
OTP and Warning Hysteresis				10		°C
Input Pull-Low $100k\Omega$ Resistor	R <sub>Low</sub>	VIN = 5V	70	115	160	kΩ



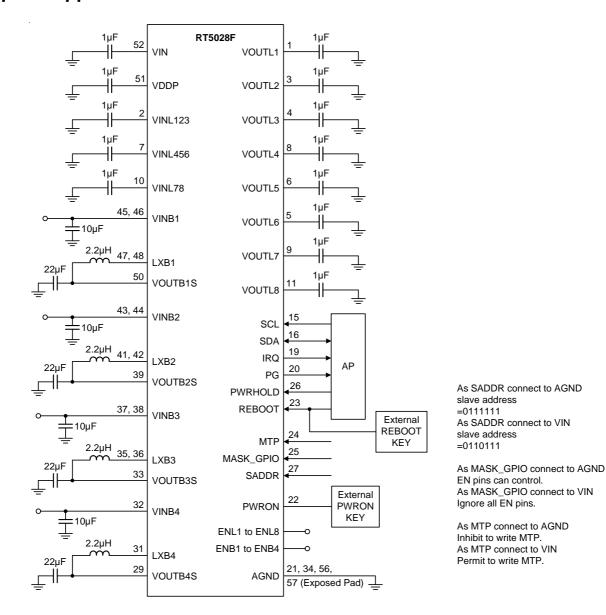
Parame	ter	Symbol	Test Coi	nditions	Min	Тур	Max	Unit	
Buck1 to Buck4	1	1	1			·			
Input Voltage		V <sub>INB</sub>			3.15		5.5	V	
Consumption Cu	ırrent	I <sub>VINB</sub>	AUTO mode I <sub>OUT</sub> = 0	mA, each Buck	10	30	50	μΑ	
Output Voltage A	Accuracy	Voutacc	3.1V < V <sub>IN</sub> < 5.5V, 1r	nA < I <sub>OUT</sub> < I <sub>MAX</sub>	-3		3	%	
Switching Freque	ency	fsw	l <sup>2</sup> C programmable		0.5		2.00	MHz	
Switching Freque	ency		1MHz < fsw		-10		10	%	
Accuracy			$f_{SW} \leq 1MHz$		-20		20	70	
			Buck1		3.1	4.4	5.8		
Peak Current Lir	mit	OCP	Buck2		2.8	4	5.2	Α	
Peak Current Lir	IIIL	OCP	Buck3		2.6	3.7	4.8	A	
			Buck4		2.8	4	5.2		
Under-Voltage P	rotection	UVP	VOUTB1S to VOUTI target)	B4S < 0.66 x (Vout	56	66	76	%	
			Buck1		2.4				
Mariana Outro	1. 0	IMAX	Buck2		2		-	1 ,	
Maximum Outpu	Maximum Output Current		Buck3		1.6			A	
			Buck4		2				
High-Side On-Re	esistance	R <sub>pon</sub>	V <sub>IN</sub> = 3.7V		50	150	250	mΩ	
Low-Side On-Re	sistance	R <sub>non</sub>	V <sub>IN</sub> = 3.7V		40	110	160	mΩ	
LDO1 to LDO8									
Input Voltage for VINL123/456/78		VINL			2.5		5.5	٧	
Output Voltage I	_DO123/78	Voutl	$3.1V \le V_{IN} \le 5.5V$ , $50\mu A \le I_{OUT} \le I_{MAX}$		-3		3	%	
Output Voltage I	_DO456	Voutl	$3.1V \le V_{IN} \le 5.5V$ , $50\mu A \le I_{OUT} \le I_{MAX}$		-3		3	%	
Output Current		lout			300			mA	
Output Short Cu	rrent	Isht			330	450	600	mA	
Voltage Differen	00	VIN – VOUT	V <sub>IN</sub> > 3.1V	VIN = VSET,	0.05	0.10	0.30	W	
Voltage Differen	ce	VIN – VOUT	V <sub>IN</sub> > 2.5V	IOUT = IOUTMAX	0.05	0.11	0.50	V	
Supply Current		I <sub>SS</sub>	I <sub>OUT</sub> = 0mA		10	50	75	μΑ	
Shutdown Curre	Shutdown Current				0	1	2	μΑ	
Control Input Pin Electrical Characteris			stics						
Voltage Output I	_ow	VoL			-		0.4	V	
Input Voltage	High-Level	ViH			1.5			\/	
input voltage	Low-Level	VIL					0.7	✓         V	
PG Pin Electric	al Characte	ristics							
Output Low Volt	age PG		Isink = 1mA,V <sub>IN</sub> = 3.15V to 5.5V				0.2	V	
Output High Lea	kage PG		V <sub>IN</sub> = 3.15V to 5.5V		-1	0	1	μΑ	



- Note 1. Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.
- Note 2.  $\theta_{JA}$  is measured under natural convection (still air) at  $T_A = 25^{\circ}$ C with the component mounted on a high effectivethermal-conductivity four-layer test board on a JEDEC 51-7 thermal measurement standard.  $\theta_{JC}$  is measured at the exposed pad of the package.
- Note 3. Devices are ESD sensitive. Handling precaution is recommended.
- Note 4. The device is not guaranteed to function outside its operating conditions.
- Note 5. Limits apply to the recommended operating temperature range of -40°C to 85°C, unless otherwise noted. Minimum and maximum limits are verified through test, design, or statistical correlation. Typical values represent the most likely parametric norm at T<sub>A</sub> = 25°C, and are provided for reference purposes only. Unless otherwise stated the following conditions apply :  $V_{IN} = 3.15V$  to 5.5V.
- Note 6. In applications where high power dissipation or poor package thermal resistance is present, the maximum ambient temperature may have to be derated. Maximum ambient temperature (TA-MAX) is dependent on the maximum operating junction temperature (T<sub>J-MAX</sub> = 125°C), the maximum power dissipation of the device in the application (P<sub>D-MAX</sub>), and the junction-to-ambient thermal resistance of the part/package in the application ( $R_{\theta JA}$ ), as given by the following equation :  $T_{A-MAX} = T_{J-MAX} - (R_{\theta_{JA}} \times P_{D-MAX})$ .



## **Typical Application Circuit**

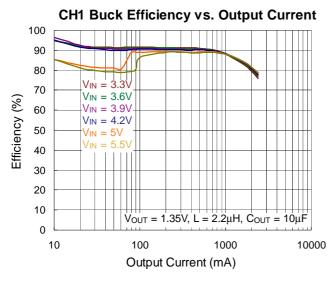


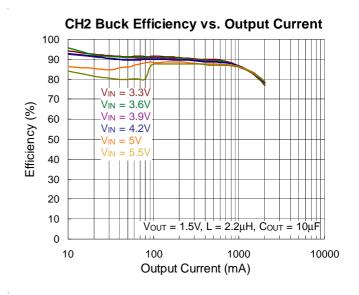
#### **Suggested Components for Typical Application Circuit**

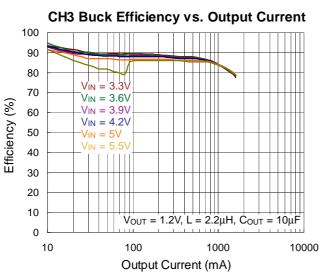
Description	Part Number	Manufacturer
Industor for Buck 2 2.4	MDWK4040T2R2MMV	TAIYO
Inductor for Buck-2.2μH	NRS5030T2R2NMGJV	TAIYO
C <sub>IN</sub> for Buck-10μF	C1206X7R1E516DT	Murata
CIN 101 Buck-10μF	EMK316AB7106KL-T	TAIYO
Court for Buck 22E	C1206X7R22E416DT	Murata
C <sub>OUT</sub> for Buck-22μF	JMK316AB7226KL-TR	TAIYO
C <sub>IN</sub> /C <sub>OUT</sub> for LDO/VIN/VDDP-1μF	C0603X7R1E216DT	Murata
CIN/COUT TO EDO/VIN/VDDF-TµF	EMK107B7105KA-T	TAIYO

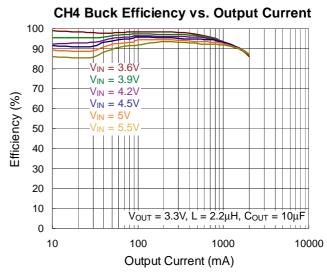


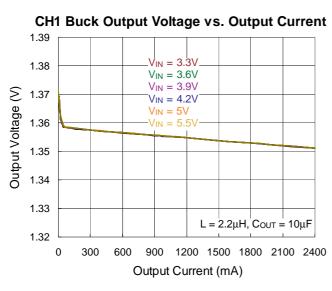
## **Typical Operating Characteristics**

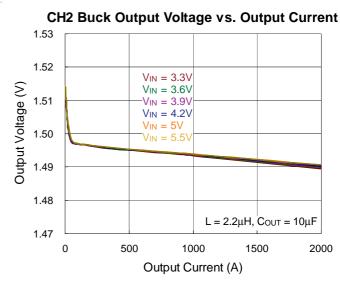








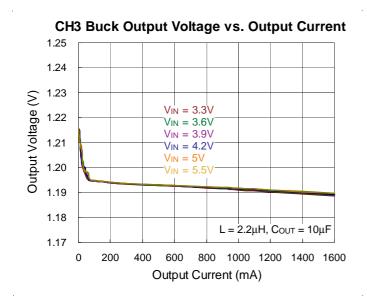


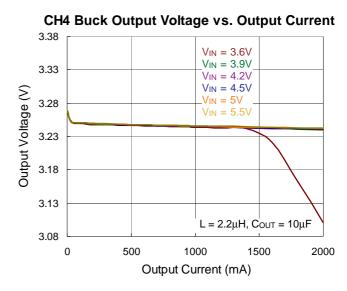


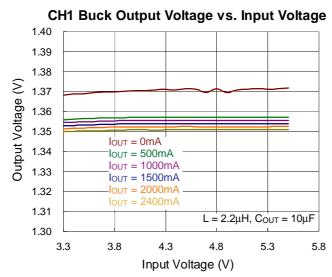
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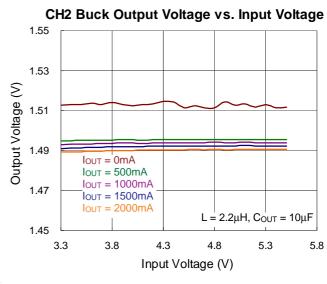
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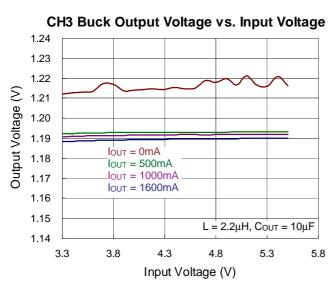


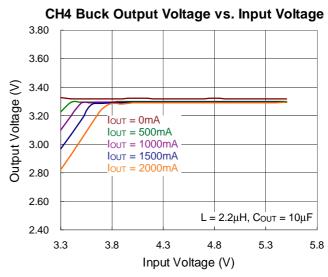




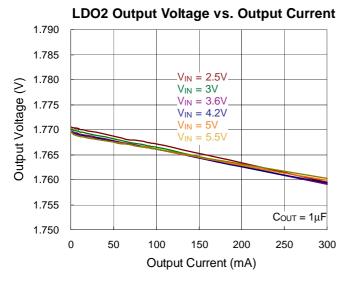


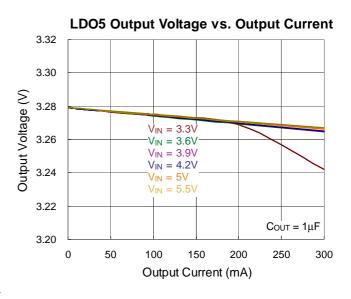


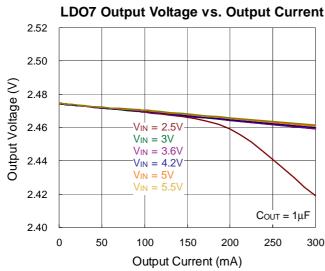


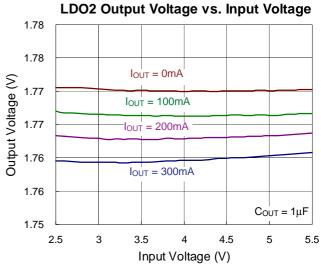


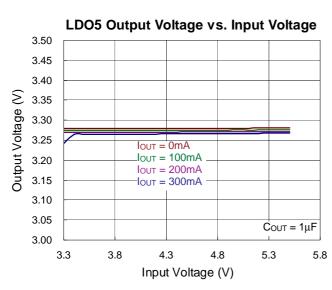


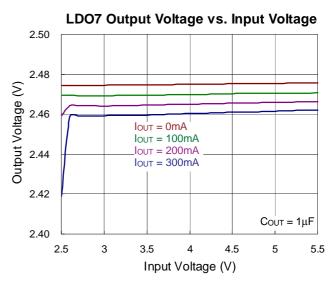












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## **Application Information**

The RT5028F is a highly-integrated solution for automotive system including PMIC and memory system. The RT5028F application mechanism and I<sup>2</sup>C compatible interface are introduced in later sections. The system's slave address is 0110111 (As SADDR = high) or 0111111 (As SADDR = low).

PMIC - Power management system provides 8 low dropout linear regulator and 4 high efficiency synchronous stepdown DC-DC converters. Power-On and Power-Off sequences are control by PWRON and REBOOT input pins. Detail time sequence control is described in Power ON/OFF diagram. The I<sup>2</sup>C interface can program individual regulator output voltage as well as on/off control and voltage setting.

#### I<sup>2</sup>C Interface Timing Diagram

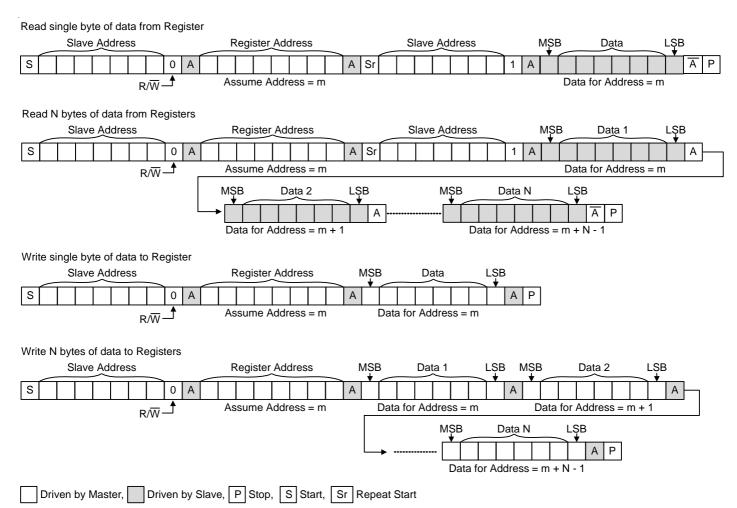
The RT5028F acts as an I<sup>2</sup>C -bus slave. The I<sup>2</sup>C-bus master configures the settings for all function blocks by sending command bytes to the RT5028F via the 2-wire I<sup>2</sup>C-bus. The I<sup>2</sup>C timing diagrams are list in the following.

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
I <sup>2</sup> C Interface Electrical Charac	cteristics					
SDA, SCLK Input High Level Threshold			1.5			٧
SDA, SCLK Input Low Level Threshold					0.4	٧
SCLK Clock Rate	f <sub>SCL</sub>				400	kHz
Hold Time (Repeated) START Condition. After this period, the first clock pulse is generated	thd;sta		0.6			μs
LOW Period of the SCL Clock	tLOW		1.3			μS
HIGH Period of the SCL Clock	tHIGH		0.6			μS
Set-Up Time for a Repeated START Condition	tsu;sta		0.6			μs
Data Hold Time	t <sub>HD;DAT</sub>		0		0.9	μS
Data Set-Up Time	tsu;dat		100			ns
Set-Up Time for STOP Condition	tsu;sto		0.6			μs
Bus Free Time Between a STOP and START Condition	t <sub>BUF</sub>		1.3			μS
Rise Time of Both SDA and SCL Signals	t <sub>R</sub>		20		300	ns
Fall Time of Both SDA and SCL Signals	tF		20		300	ns
SDA and SCL Output Low Sink Current	loL	SDA or SCL voltage = 0.4V	2			mA

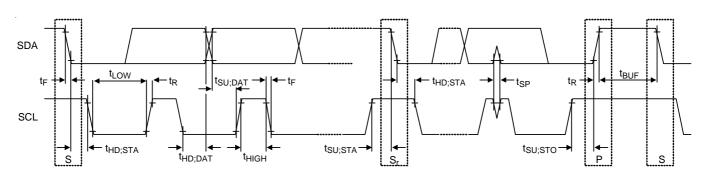
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#### **Read and Write Function**



#### I<sup>2</sup>C Waveform Information





#### **PMIC**

#### **Power Channels Control Methodology**

When VIN power Good or PWRON event occurs, the PMIC will follow the power on sequence to turn on channels.

During normal operation, users can use the REBOOT pin rapid to restart PMIC. Another PWROFF event, OTP, VIN OVP, VIN UVLO, UVP or PWROFF occurs, PMIC will execute the power off. The power on/off mode control is shown in Figure 1 and Table 1.

#### **VIN Over-Voltage Protection**

The device has a built-in OVP circuit which monitors the input voltage. If the voltage exceeds the OVP threshold

(typ value = 5.95V), the device stops operating. As soon as the voltage drops below the low threshold (typ value = 5.65V), the device starts to operate again. Therefore, overvoltage protection is implemented to prevent the input voltage from exceeding critical values to damage the device.

Base on ISO 7637 and 16750 test case, if VIN vary violently, the device will trigger UVP or OVP (VIN rising up slew rate should be less than 5V/1ms) and then stops operating. The device needs to do reset by REBOOT pin or VIN (VIN < 1.7V) to resume operation.

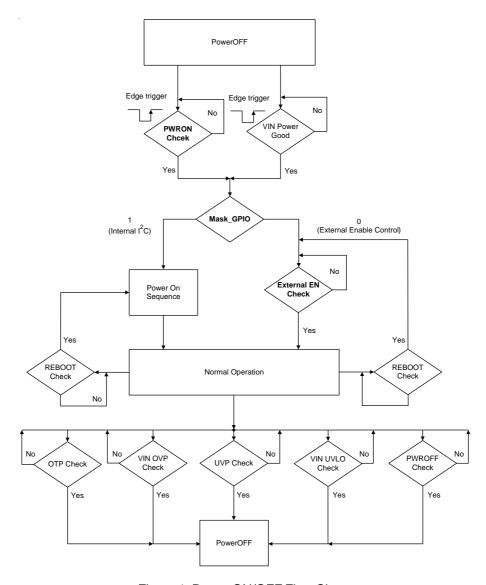


Figure 1. Power ON/OFF Flow Chart



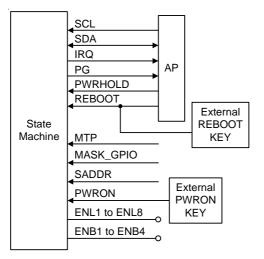
**Table 1. Protection List** 

Function	Protection Type	Threshold (Typical Value)	Deglitch/ Delay Time	Protection Method	Reset Method (Typical Value)
	POR	VIN < 1.7V	2μs	Disable all channels	VIN > 2V
VIN	UVLO	VIN < VOFF setting	32μs	Disable all channels (Option)	VIN > VOFF setting + 0.4V 1. Reset by Reboot pin 2. VIN reset (VIN < 1.7V)
	OVP	VIN > 5.95V	No delay	Disable all channels	VIN < 5.65V 1. Reset by Reboot pin 2. VIN reset (VIN < 1.7V)
	OCP, 0x16 [7:4] = 0	PMOS current > OCP value	No delay	Disable channel	Re-enable by I <sup>2</sup> C     EN bit.     Reset by Reboot pin
Buck1 to Buck4	OCP, 0x16 [7:4] = 1	PMOS current > OCP value	Control by 0x15 [5:4] SHDN_DLYTIME	Disable all channels	1. Reset by PWRON pin 2. VIN reset (VIN < 1.7V)
	VOUT UVP	VOUT < 0.66 x (VOUT Target)	No delay	Disable channel (Option)	<ol> <li>Re-enable by I<sup>2</sup>C</li> <li>EN bit.</li> <li>Reset by Reboot pin.</li> <li>VIN reset (VIN &lt; 1.7V)</li> </ol>
LDO1 to LDO8	Current Limit	PMOS current > OCP value	No delay	Current Limit	Hiccup Until fail event to be dissolved
Thermal	Thermal shutdown	Temperature > 165°C	No delay	Disable all channels (Option)	Temperature < 155°C  1. Reset by PWRON pin.  2. VIN reset (VIN < 1.7V)



#### PMIC - POWER ON/OFF Setting

The circuit setting for communication between the RT5028F and AP is showed as below.



As SADDR connect to AGND slave address
=0111111
As SADDR connect to VIN slave address
=0110111

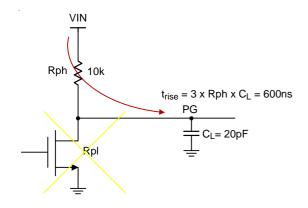
As MASK\_GPIO connect to AGND EN pins can control.
As MASK\_GPIO connect to VIN Ignore all EN pins.

As MTP connect to AGND Inhibit to write MTP.
As MTP connect to VIN Permit to write MTP.

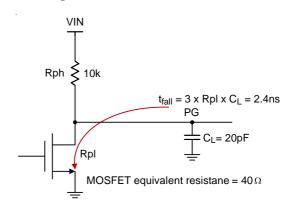
#### **PG Pin**

The PG comparator features an open drain output. The PG pin pull high to input voltage with  $10k\Omega$  which slew rate define as follow.

#### **PG Rising Slew Rate**



#### **PG Falling Slew Rate**





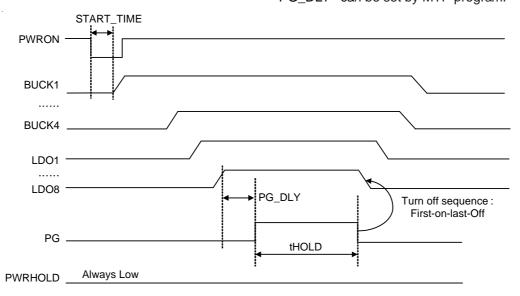
<b>GPIO</b>	Pin	Pull-U	n/Down	<b>Defined</b>
GFIO	ГШ	r un-o		Delilled

Pin No.	Pin Name	GPIO Pin Pull-Up/Down Defined	Resistor
12	ENL4	Internal 100kΩ pull low resistor	Internal
13	ENL5	Internal 100kΩ pull low resistor	Internal
14	ENL6	Internal 100kΩ pull low resistor	Internal
15	SCL	Open drain, need to connect pull up resistor with range from 2.2k $\Omega$ to 10k $\Omega$	External
16	SDA	Open drain, need to connect pull up resistor with range from 2.2k $\Omega$ to 10k $\Omega$	External
17	ENL7	Internal 100kΩ pull low resistor	Internal
18	ENL8	Internal 100kΩ pull low resistor	Internal
22	PWRON	Internal 100kΩ pull up resistor	Internal
23	REBOOT	Internal 100kΩ pull low resistor	Internal
24	MTP	Internal 100kΩ pull low resistor	Internal
26	PWRHOLD	Internal 100kΩ pull low resistor	Internal
27	SADDR	Internal 100kΩ pull low resistor	Internal
28	ENB4	Internal 100kΩ pull low resistor	Internal
30	ENB3	Internal 100kΩ pull low resistor	Internal
40	ENB2	Internal 100kΩ pull low resistor	Internal
49	ENB1	Internal 100kΩ pull low resistor	Internal
53	ENL1	Internal 100kΩ pull low resistor	Internal
54	ENL2	Internal 100kΩ pull low resistor	Internal
55	ENL3	Internal 100kΩ pull low resistor	Internal

#### **Power Hold Function**

When the "PWRHOLD" signal does not come during THOLD time, the RT5028F will do shutdown sequence.

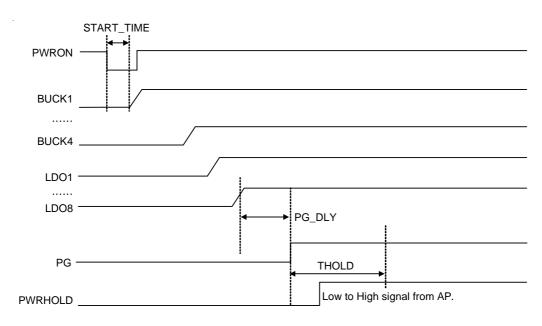
If users want to disable power hold function, set "DisTHOLD" bit in I<sup>2</sup>C register 0x10 bit[0] to disable this function. In the timing diagram below, the "THOLD" and "PG\_DLY" can be set by MTP program.



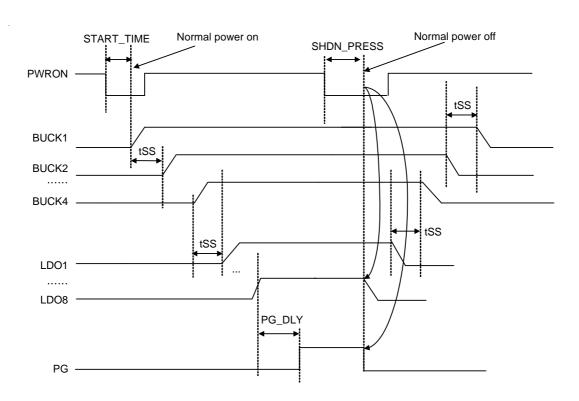
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When AP sends the "PWRHOLD" signal during THOLD time, the RT5028F will keep power-on.

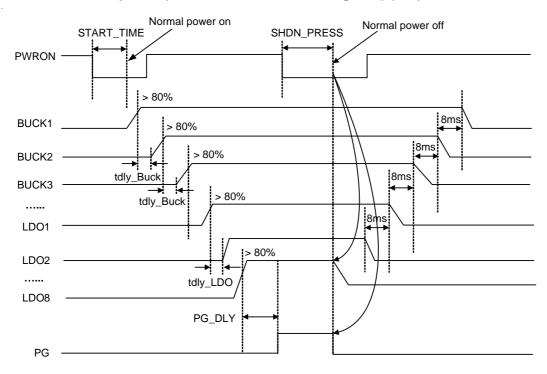


#### Timing Based ON/OFF Sequence (PWRON\_NORMOFF\_EN, Reg0x15[0] = 1)





#### Level Based ON/OFF Sequence (PWRON\_NORMOFF\_EN, Reg0x15[0] = 1)



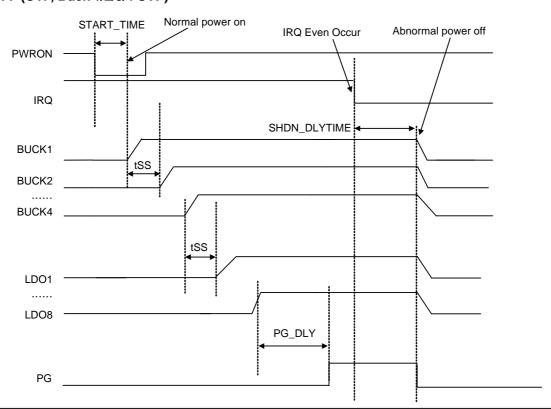
Note.

 $Sequence: BUCK1 \rightarrow BUCK2 \rightarrow BUCK3 \rightarrow BUCK4 \rightarrow LDO1 \rightarrow LDO2 \rightarrow LDO3 \rightarrow LDO4 \rightarrow LDO5 \rightarrow LDO6 \rightarrow LDO7 \rightarrow LDO8 \rightarrow LDO9 \rightarrow$ 

tdly\_Buck : 192 x (1/fsw) + 40µs ±35%

tdly\_LDO: 110µs ±20% (If previous one channel is Buck, additional delay time 32 x (1/fsw) need to be added to tdly\_LDO.)

#### Abnormal OFF (OTP, Buck 1/2/3/4 UVP)

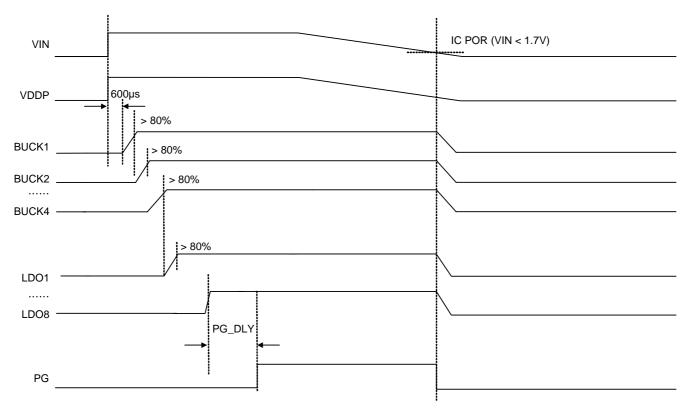


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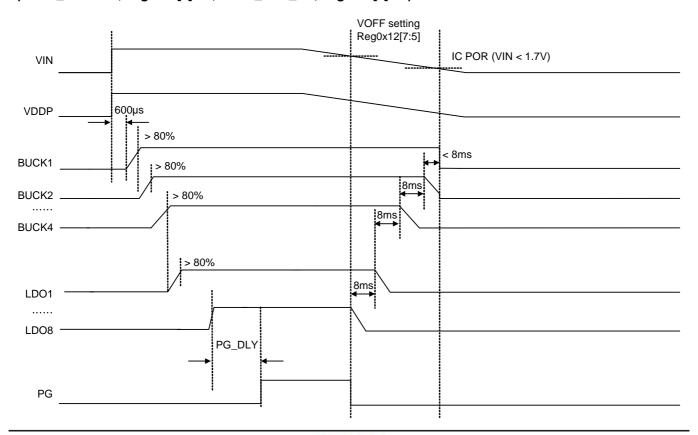
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#### Based ON/OFF Sequence by VIN (VINLV\_ENSHDN, Reg0x16[1] = 0)



#### (VINLV\_ENSHDN, Reg0x16[1] = 1; VINLV\_SEQ\_EN, Reg0x16[0] = 1)





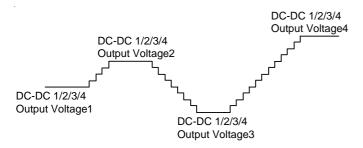
#### PMU On/Off Sequence Setting

In the RT5028F, users can set the power on/off sequence and output voltage by I<sup>2</sup>C register 0x01 to 0x04 for Buck output voltage, 0x07 to 0x0E for LDO output voltage and 0x2C to 0X32 for startup sequence setting.

#### Synchronous Step-Down DC-DC Converter

Four current mode synchronous step-down DC-DC converters operate with internal power MOSFETs and compensation network. These channels supply the power core chip of portable system. They can be operated at 100% maximum duty cycle to extend battery operating voltage range. When the input voltage is close to the output voltage, the converter enters low dropout mode with low output ripple. The operating frequency range of step-down converter is 0.5MHz to 2MHz.

Four step-down converters have RAMP control function as the following diagram.



#### Input and Output Capacitors Selection

The RT5028F is designed to work with low ESR ceramic capacitors. The *effective* value of these capacitors is defined as the actual capacitance under voltage bias and temperature. All ceramic capacitors have a large voltage coefficient, in addition to normal tolerances and temperature coefficients. Under D.C. bias, the capacitance value drops considerably. Larger case sizes or higher voltage capacitors are better in this regard. To help mitigate these effects, multiple small capacitors can be used in parallel to bring the minimum *effective* capacitance up to the desired value.

The input capacitance,  $C_{\text{IN}}$ , is needed to filter the trapezoidal current at the source of the top MOSFET. A low ESR input capacitor with larger ripple current rating should be used for the maximum RMS current. RMS current is given by :

$$I_{RMS} = I_{OUT(MAX)} \times \frac{V_{OUT}}{V_{IN}} \times \sqrt{\frac{V_{IN}}{V_{OUT}}} - 1$$

This formula has a maximum at  $V_{IN} = 2V_{OUT}$ , where IRMS = I<sub>OUT</sub> / 2. This simple worst case condition is commonly used for design because even significant deviations do not offer much relief. Note that ripple current ratings from capacitor manufacturers are often based on only 2000 hours of life, which makes it advisable to either further derate the capacitor or choose a capacitor rated at a higher temperature than required. Several capacitors may also be placed in parallel to meet size or height requirements in the design. The selection of C<sub>OUT</sub> is determined by the effective series resistance (ESR) that is required to minimize voltage ripple, load step transients, and the amount of bulk capacitance that is necessary to ensure that the control loop is stable. Loop stability can be examined by viewing the load transient response as described in a later section. The output ripple,  $\Delta V_{OUT}$ , is determined by:

$$\Delta V_{OUT} \le \Delta I_L \left[ ESR + \frac{1}{8 \times f_{SW} \times C_{OUT}} \right]$$

The output ripple is highest at maximum input voltage since DIL increases with input voltage. Multiple capacitors placed in parallel may be needed to meet the ESR and RMS current handling requirements. Dry tantalum, special polymer, aluminum electrolytic and ceramic capacitors are all available in surface mount packages. Special polymer capacitors offer very low ESR but have lower capacitance density than other types. Tantalum capacitors have the highest capacitance density but it is important to only use types that have been surge tested for use in switching power supplies. Aluminum electrolytic capacitors have significantly higher ESR but can be used in cost-sensitive applications provided that consideration is given to ripple current ratings and long-term reliability. Ceramic capacitors have excellent low ESR characteristics but can have a high voltage coefficient and audible piezoelectric effects. The high Q of ceramic capacitors with trace inductance can also lead to significant ringing.



#### **Using Ceramic Input and Output Capacitors**

Higher values, lower cost ceramic capacitors are now becoming available in smaller case sizes. Their high ripple current, high voltage rating and low ESR make them ideal for switching regulator applications. However, care must be taken when these capacitors are used at the input and output. When a ceramic capacitor is used at the input and the power is supplied by a wall adapter through long wires, a load step at the output can induce ringing at the input, VIN. At best, this ringing can couple to the output and be mistaken as loop instability. At worst, a sudden inrush of current through the long wires can potentially cause a voltage spike at VIN large enough to damage the part. Page 8 shows the nominal values of input/output capacitance recommenced for the RT5028F.

#### **Inductor Selection**

For a given input and output voltage, the inductor value and operating frequency determine the ripple current. The ripple current  $\Delta I_L$  increases with higher  $V_{IN}$  and decreases with higher inductance:

$$\Delta I_{L} = \left[ \frac{V_{OUT}}{f_{OSC} \times L} \right] \times \left[ 1 - \frac{V_{OUT}}{V_{IN}} \right]$$

Having a lower ripple current reduces the ESR losses in the output capacitors and the output voltage ripple. Highest efficiency operation is achieved at low frequency with small ripple current. This, however, requires a large inductor. A reasonable starting point for selecting the ripple current is  $\Delta I_L = 0.4$  (IMAX). The largest ripple current occurs at the highest V<sub>IN</sub>. To guarantee that the ripple current stays below a specified maximum, the inductor value should be chosen according to the following equation:

$$L = \left\lceil \frac{V_{OUT}}{f_{OSC} \times \Delta I_{L(MAX)}} \right\rceil \times \left\lceil 1 - \frac{V_{OUT}}{V_{IN(MAX)}} \right\rceil$$

#### **Inductor Core Selection**

Once the value for L is known, the type of inductor must be selected. High efficiency converters generally cannot afford the core loss found in low cost powdered iron cores, forcing the use of more expensive ferrite or permalloy cores. Actual core loss is independent of core size for a fixed inductor value but it is very dependent on the inductance selected. As the inductance increases, core losses decrease. However, increased inductance requires more turns of wire and therefore copper losses will increase.

Ferrite designs have very low core losses and are preferred at high switching frequencies, so design goals can concentrate on copper loss and preventing saturation.

Ferrite core material saturates "hard" which means that inductance collapses abruptly when the peak design current is exceeded.

This results in an abrupt increase in inductor ripple current and consequent output voltage ripple.

Do not allow the core to saturate!

Different core materials and shapes will change the size/ current and price/current relationship of an inductor. Toroid or shielded pot cores in ferrite or permalloy materials are small and don't radiate energy but generally cost more than powdered iron core inductors with similar characteristics. The choice of which style inductor to use mainly depend on the price vs. size requirements and any radiated field/EMI requirements.

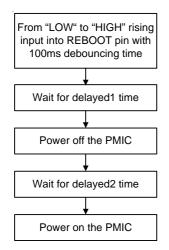
#### **REBOOT Function**

As the REBOOT pin is set from low to high, the REBOOT function will be active. The REBOOT's FSM is shown as below. It concludes 100ms de-bouncing time and delay1/ delay2 power off delay time.

**Table 2. REBOOT Input Control Setting** 

	Description	Default
delayed2	00:100ms 10:1s	Option
delayed1	01:500ms 11:2s	Option
Action	delayed1 power-off then delayed2 power-on PMIC	

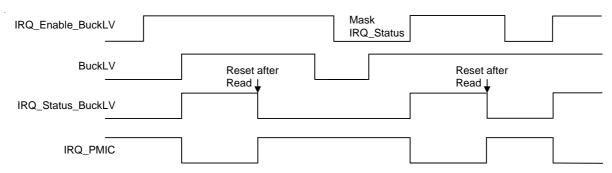




#### **IRQ Table**

We summarize all IRQ items in the register table. All IRQ\_status registers are implemented as reset after read. If IRQ\_enable bit is Low, the IRQ\_status bit will not update status. IRQ\_enable will mask IRQ\_status to trigger IRQ\_PMIC Low, so the system can decide which interrupt is necessary.

#### Waveform - (when the other IRQ\_status are low)



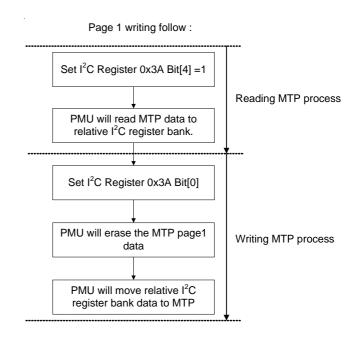
Waveform - (when the other IRQ\_status are low)

\* OTW125/OTW100 means the 125°C/100°C pre-warming over-temperature.

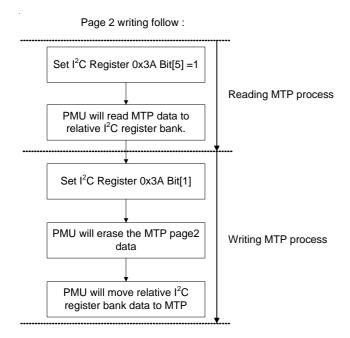
#### **EEPROM (MTP) Control Flow**

The RT5028F embeds 32 bytes MTP memory, and it allows users to save some  $I^2C$  register bank data to MTP. When the  $I^2C$  register 0x3A Bit[0]/Bit[1] is wrote to "1", the MTP Page1/Page2 will execute erase process firstly.

Because the erase process will be done in every writing time, the MTP data will be missed. So it would be best for users to read data from MTP to I<sup>2</sup>C first before executing writing process.







#### **Thermal Considerations**

The junction temperature should never exceed the absolute maximum junction temperature T<sub>J(MAX)</sub>, listed under Absolute Maximum Ratings, to avoid permanent damage to the device. The maximum allowable power dissipation depends on the thermal resistance of the IC package, the PCB layout, the rate of surrounding airflow, and the difference between the junction and ambient temperatures. The maximum power dissipation can be calculated using the following formula:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

where T<sub>J(MAX)</sub> is the maximum junction temperature, T<sub>A</sub> is the ambient temperature, and  $\theta_{JA}$  is the junction-to-ambient thermal resistance.

For continuous operation, the maximum operating junction temperature indicated under Recommended Operating Conditions is 125°C. The junction-to-ambient thermal resistance,  $\theta_{JA}$ , is highly package dependent. For a WQFN-56L 7x7 package, the thermal resistance,  $\theta_{JA}$ , is 27°C/W on a standard JEDEC 51-7 high effective-thermalconductivity four-layer test board. The maximum power dissipation at T<sub>A</sub> = 25°C can be calculated as below:

 $P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / (27^{\circ}C/W) = 3.7W$  for a WQFN-56L 7x7 package.

The maximum power dissipation depends on the operating ambient temperature for the fixed T<sub>J(MAX)</sub> and the thermal resistance,  $\theta_{JA}$ . The derating curves in Figure 2 allows the designer to see the effect of rising ambient temperature on the maximum power dissipation.

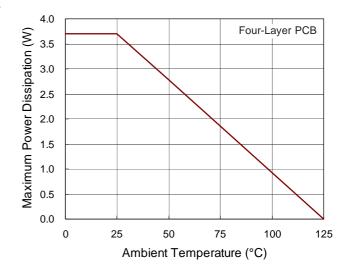


Figure 2. Derating Curve of Maximum Power Dissipation

#### **Layout Consideration**

For the best performance of the RT5028F, the following PCB layout guidelines must be strictly followed.

- Place the input and output capacitors as close as possible to the input and output pins respectively for good filtering.
- Keep the main power traces as wide and short as possible.
- The switching node area connected to LX and inductor should be minimized for lower EMI.
- Connect the GND and Exposed Pad to a strong ground plane for maximum thermal dissipation and noise protection.
- Directly connect the output capacitors to the feedback network of each channel to avoid bouncing caused by parasitic resistance and inductance from the PCB trace.



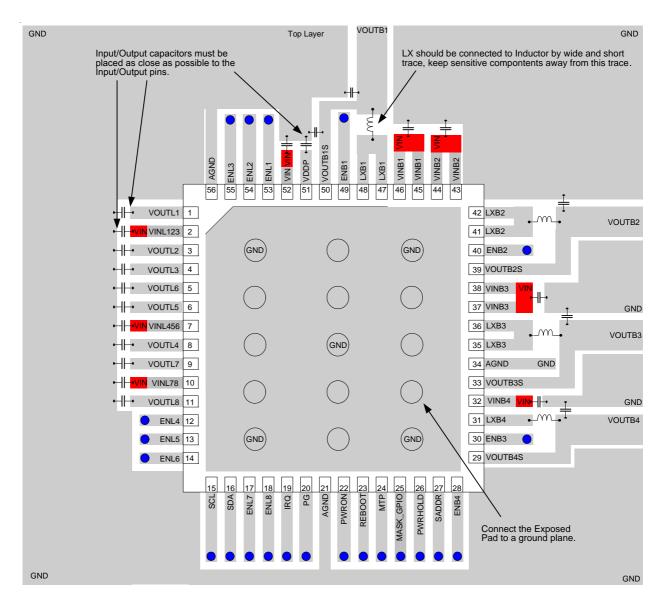


Figure 3. PCB Layout Guide



Table 3. I<sup>2</sup>C Register Table

		Detail Description		T
Address	00	Device ID		
Bit	Name	Description	Read/Write	Reset Value
[7:4]	VENDOR_ID	Vendor Identification : Telechips : 1000b	R	1000
[3:0]	CHIP_REV	Chip Revision	R	0111
Address	01	BUCKcontrol1		
Bit	Name	Description	R/W	Reset Value
[7:2]	Buck1Output[5:0]	Buck1 output voltage regulation 000000 : 0.7V, 25mV per step 000001 : 0.725V  101100 : 1.8V  111111 : 1.8V	R/W	Option
[1:0]	Buck1VRC	VRC setting 00 : 25mV/10μs, 01 : 50mV/10μs, 10 : 100mV/10μs, 11 : 200mV/10μs	R/W	Option
Address	02	BUCKcontrol2		
Bit	Name	Description	R/W	Reset Value
[7:2]	Buck2Output[5:0]	Buck2 output voltage regulation 000000 : 0.7V, 25mV per step 000001 : 0.725V  101100 : 1.8V  111111 : 1.8V	R/W	Option
[1:0]	Buck2VRC	VRC setting 00 : 25mV/10μs, 01 : 50mV/10μs, 10 : 100mV/10μs, 11 : 200mV/10μs	R/W	Option
Address	03	BUCKcontrol3		
Bit	Name	Description	R/W	Reset Value
[7:2]	Buck3Output[5:0]	Buck3 output voltage regulation 000000 : 0.7V, 50mV per step 000001 : 0.75V  111010 : 3.6V  111111 : 3.6V	R/W	Option
[1:0]	Buck3VRC	VRC setting 00 : 50mV/10μs, 01 : 100mV/10μs, 10 : 200mV/10μs, 11 : 400mV/10μs	R/W	Option



Address	04	BUCKcontrol4		
Bit	Name	Description	R/W	Reset Value
[7:2]	Buck4Output[5:0]	Buck4 output voltage regulation 000000 : 0.7V, 50mV per step 000001 : 0.75V  111010 : 3.6V  111111 : 3.6V	R/W	Option
[1:0]	Buck4VRC	VRC setting 00 : 50mV/10μs, 01 : 100mV/10μs, 10 : 200mV/10μs, 11 : 400mV/10μs	R/W	Option
Address	05	VRC Control		
Bit	Name	Description	R/W	Reset Value
7	Buck1VRC_EN	Buck1 VRC 0: Disable - voltage ramps up to target voltage with one time 1: Enable - voltage ramps up to target voltage with slope control	R/W	Option
6	Buck2VRC_EN	Buck2 VRC 0 : Disable - voltage ramps up to target voltage with one time 1 : Enable - voltage ramps up to target voltage with slope control	R/W	Option
5	Buck3VRC_EN	Buck3 VRC 0: Disable - voltage ramps up to target voltage with one time 1: Enable - voltage ramps up to target voltage with slope control	R/W	Option
4	Buck4VRC_EN	Buck4 VRC 0: Disable - voltage ramps up to target voltage with one time 1: Enable - voltage ramps up to target voltage with slope control	R/W	Option
[3:0]	Reserved		R/W	0000
Address	06	BUCK Mode		
Bit	Name	Description	R/W	Reset Value
7	Buck1mode	Buck1 mode 0 : Force PWM 1 : Auto Mode (PSM/PWM)	R/W	Option
6	Buck2mode	Buck2 mode 0 : Force PWM 1 : Auto Mode (PSM/PWM)	R/W	Option
5	Buck3mode	Buck3 mode 0 : Force PWM 1 : Auto Mode (PSM/PWM)	R/W	Option

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4	Buck4mode	Buck4 mode 0 : Force PWM 1 : Auto Mode (PSM/PWM)	R/W	Option
3	Buck1oms	Buck1 output off mode state 0 : Floating 1 : Ground-discharged	R/W	Option
2	Buck2oms	Buck2 output off mode state 0 : Floating 1 : Ground-discharged	R/W	Option
1	Buck3oms	Buck3 output off mode state 0 : Floating 1 : Ground-discharged	R/W	Option
0	Buck4oms	Buck4 output off mode state 0 : Floating 1 : Ground-discharged	R/W	Option
Address	07	LDOcontrol1		
Bit	Name	Description	R/W	Reset Value
7	Reserved		R/W	0
[6:0]	LDO1OUT[6:0]	LDO1 output voltage regulation 0000000 : 1.6V, 25mV per step 0000001 : 1.625V  1010000 : 3.6V (MAX)  1111111 : 3.6V (MAX)	R/W	Option
Address	08	LDOcontrol2		
Bit	Name	Description	R/W	Reset Value
7	Reserved	·	R/W	0
[6:0]	LDO2OUT[6:0]	LDO2 output voltage regulation 0000000 : 1.6V, 25mV per step 0000001 : 1.625V  1010000 : 3.6V (MAX)  1111111 : 3.6V (MAX)	R/W	Option
Address	09	LDOcontrol3		
Bit	Name	Description	R/W	Reset Value
7	Reserved		R/W	0
[6:0]	LDO3OUT[6:0]	LDO3 output voltage regulation 0000000 : 1.6V, 25mV per step 0000001 : 1.625V  1010000 : 3.6V (MAX)	R/W	Option
		1111111 : 3.6V (MAX)		



Address	0A	LDOcontrol4		
Bit	Name	Description	R/W	Reset Value
7	Reserved		R/W	0
[6:0]	LDO4OUT[6:0]	LDO4 output voltage regulation 0000000 : 3 V, 25mV per step 0000001 : 3.025V  0011000 : 3.6V (MAX)  1111111 : 3.6V (MAX)	R/W	Option
Address	0B	LDOcontrol5		
Bit	Name	Description	R/W	Reset Value
7	Reserved		R/W	0
[6:0]	LDO5OUT[6:0]	LDO5 output voltage regulation 0000000 : 3V, 25mV per step 0000001 : 3.025V  0011000 : 3.6V (MAX)  1111111 : 3.6V (MAX)	R/W	Option
Address	0C	LDOcontrol6		
Bit	Name	Description	R/W	Reset Value
7	Reserved		R/W	0
[6:0]	LDO6OUT[6:0]	LDO6 output voltage regulation 0000000 : 3.0V, 25mV per step 0000001 : 3.025V  0011000 : 3.6V (MAX)  1111111 : 3.6V (MAX)	R/W	Option
Address	0D	LDOcontrol7		
Bit	Name	Description	R/W	Reset Value
7	Reserved		R/W	0
[6:0]	LDO7OUT[6:0]	LDO7output voltage regulation 0000000 : 1.6V, 25mV per step 0000001 : 1.625V  1010000 : 3.6V (MAX)  1111111 : 3.6V (MAX)	R/W	Option



Address	0E	LDOcontrol8		
Bit	Name	Description	R/W	Reset Value
7	Reserved		R/W	0
[6:0]	LDO8OUT[6:0]	LDO8utput voltage regulation 0000000 : 1.6V, 25mV per step 0000001 : 1.625V  1010000 : 3.6V (MAX)  1111111 : 3.6V (MAX)	R/W	Option
Address	0F	LDOs off mode state		
Bit	Name	Description	R/W	Reset Value
7	LDO8oms	LDO8 output off mode state 0 : Floating 1 : Ground-discharged	R/W	1
6	LDO7oms	LDO7 output off mode state 0 : Floating 1 : Ground-discharged	R/W	1
5	LDO6oms	LDO6 output off mode state 0 : Floating 1 : Ground-discharged	R/W	1
4	LDO5oms	LDO5 output off mode state 0 : Floating 1 : Ground-discharged	R/W	1
3	LDO4oms	LDO4 output off mode state 0 : Floating 1 : Ground-discharged	R/W	1
2	LDO3oms	LDO3 output off mode state 0 : Floating 1 : Ground-discharged	R/W	1
1	LDO2oms	LDO2 output off mode state 0 : Floating 1 : Ground-discharged	R/W	1
0	LDO1ms	LDO1output off mode state 0 : Floating 1 : Ground-discharged	R/W	1
Address	10	REBOOT/PWRHOLD delay time control		
Bit	Name	Description	R/W	Reset Value
[7:6]	Delayed2[1:0]	Delayed2 setting (00 : 100ms/01 : 500ms/10 : 1s/11 : 2s)	R/W	Option
[5:4]	Delayed1[1:0]	Delayed1 setting (00 : 100ms/01 : 500ms/10 : 1s/11 : 2s)	R/W	Option
[3:2]	THOLD[1:0]	THOLD setting (00 : 100ms/01 : 500ms/10 : 1s/11 : 2s)	R/W	Option
1	Reserved		R/W	0
0	DisTHOLD	Ignore THOLD Time. 0: Keep PWRHOLD function. 1: Ignore PWRHOLD function.	R/W	Option



Address	11	ON Event Setting		
Bit	Name	Description	R/W	Reset Value
[7:5]	On_Event	Powered on because of 000 : PWRON key-pressed 001 : VIN plugged in 010 : From REBOOT pin event 111 : No event happen	R	111
[4:0]	Reserved		R/W	0
Address	12	VIN UVLO/Buck On/Off		
Bit	Name	Description	R/W	Reset Value
[7:5]	VOFF setting	VIN UVLO 2.8V to 3.5V per 0.1V to power off PMIC (Hysteresis = VOFF setting + 0.35V) 000 : 2.8V 001 : 2.9V 010 : 3V 011 : 3.1V 100 : 3.2V 101 : 3.3V 110 : 3.4V 111 : 3.5V	R/W	Option
4	Reserved		R/W	0
3	Buck4	Buck4 control (0 : Disable Buck4/1 : Enable Buck4)	R/W	Option
2	Buck3	Buck3 control (0 : Disable Buck3/1 : Enable Buck3)	R/W	Option
1	Buck2	Buck2 control (0 : Disable Buck2/1 : Enable Buck2)	R/W	Option
0	Buck1	Buck1 control (0 : Disable Buck1/1 : Enable Buck1)	R/W	Option



Address	13	LDOs On/Off		
Bit	Name	Description	R/W	Reset Value
7	LDO8	LDO8 control (0 : Disable LDO8 / 1 : Enable LDO8)	R/W	Option
6	LDO7	LDO7 control (0 : Disable LDO7 / 1 : Enable LDO7)	R/W	Option
5	LDO6	LDO6 control (0 : Disable LDO6 / 1 : Enable LDO6)	R/W	Option
4	LDO5	LDO5 control (0 : Disable LDO5 / 1 : Enable LDO5)	R/W	Option
3	LDO4	LDO4 control (0 : Disable LDO4 / 1 : Enable LDO4)	R/W	Option
2	LDO3	LDO3 control (0 : Disable LDO3 / 1 : Enable LDO3)	R/W	Option
1	LDO2	LDO2 control (0 : Disable LDO2 / 1 : Enable LDO2)	R/W	Option
0	LDO1	LDO1 control (0 : Disable LDO1 / 1 : Enable LDO1)	R/W	Option



Address	14	PWRON(Power On Key) time Parameters Setting / PG delay		
Bit	Name	Description	R/W	Reset Value
[7:6]	START_TIME	Startup time setting 00 : 100µs (pressing time - low level) 01 : 100ms 10 : 1s 11 : 2s	R/W	Option
[5:4]	L_PRESS_TIME	Long-press time setting (after Power-On, 00 : 1s (falling edge to rising edge) 01 : 1.5s 10 : 2s 11 : 2.5s Sending short/long-press IRQ to CPU ex : 1.5s → low time < 1.5s (short IRQ) → low time > 1.5s but < 6s (shutdown time) (long IRQ) → low time > 6s (shutdown time) (shutdown)	R/W	Option
[3:2]	SHDN_PRESS	Key-press forced shutdown time setting 00 : 4s/0ms (pressing time : low level) 01 : 6s/1ms 10 : 8s/1ms 11 : 10s/2ms (allow option 0/1/1/2ms by SHDN_PRESS_SHORT)	R/W	Option
[1:0]	PG_DLY	PG signal delay after the last power startup is done 00 : 10ms 01 : 50ms 10 : 100ms 11 : 200ms/5ms (allow option 5ms by PG_DLY_5ms_EN)	R/W	Option



Address	15	SHDN Control		
Bit	Name	Description	Read/Write	Reset Value
7	SHDN_CTRL	Power off setting by CPU, after set, 100ms delayed power off 0: Normal operation 1: Disable the PMIC output	R/W	0
6	SHDN_TIMING	Disable Buck/LDO only for normal power off (SHDN_CTRL = 1) 0: Disable at the same time 1: Contrary to the startup timing (first_on-last_off)	R/W	Option
[5:4]	SHDN_DLYTIME	Delayed shutdown time after send the (PWRON)key-press-forced-shutdown IRQ (when IRQ is disable, there is no delay) 00: 100ms 01: 500ms 10: 1s 11: 2s	R/W	Option
3	Reserved		R/W	0
2	PG_DLY_5ms_EN	0 : 0x14[1:0] = 11, delay is 200ms 1 : 0x14[1:0] = 11, delay is 5ms	R/W	Option
1	SHDN_PRESS_SHORT	0 : 0x14[3:2], SHDN_PRESS time is 4s/6s/8s/10s 1 : 0x14[3:2], SHDN_PRESS time is 0ms/1ms/1ms/2ms	R/W	Option
0	PWRON_NORMOFF_EN	PWRON off sequence 0 : Disable this event. 1 : Enable this event	R/W	Option
Address	16	Powered off conditions enable setting		
Bit	Name	Description	Read/Write	Reset Value
7	BCK1LV_ENSHDN	Buck1 output voltage low SHDN 0 : Disable this event. 1 : Enable this event	R/W	0
6	BCK2LV_ENSHDN	Buck2 output voltage low SHDN 0 : Disable this event. 1 : Enable this event	R/W	0
5	BCK3LV_ENSHDN	Buck3 output voltage low SHDN 0 : Disable this event. 1 : Enable this event	R/W	0
4	BCK4LV_ENSHDN	Buck4 output voltage low SHDN 0 : Disable this event. 1 : Enable this event	R/W	0
3	PWRON_ENSHDN	PWRON key-pressed forced SHDN 0 : Disable this event. 1 : Enable this event	R/W	1
2	OT_ENSHDN	Over temperature SHDN 0 : Disable this event. 1 : enable this event	R/W	1
1	VINLV_ENSHDN	VIN voltage low (VOFF) SHDN 0 : Disable this event. 1 : Enable this event	R/W	Option
0	VINLV_SEQ_EN	Off sequence after VIN voltage low (VOFF) 0: Disable this event. 1: Enable this event	R/W	Option



Address	17	OFF Event (Only reset by POR)		
Bit	Name	Description	Read/Write	Reset Value
[7:4]	OFF_Event	Powered off because of (Only shows last power-off event) 0000: VIN voltage low (VOFF) (Set by reg) 0001: Buck1 output voltage low 0010: Buck2 output voltage low 0011: Buck3 output voltage low 0100: PWRON key-pressed forced shutdown 0101: Power Off register setting 0110: Over-temperature event 0111: Reboot restart. 1000: Buck4 output voltage low 1001: PWR_HOLD fail. 1010: No event happen	R	1111
[3:0]	Reserved		R	0000
Address	28	IRQ Enable1		
Bit	Name	Description	Read/Write	Reset Value
7	OT_IRQ	Internal over-temperature was triggered, IRQ enable	R/W	1
6	Bck1LV_IRQ	Buck1 output voltage equal 66% x V <sub>Target</sub> , IRQ enable	R/W	1
5	Bck2LV_IRQ	Buck2 output voltage equal 66% x V <sub>Target</sub> , IRQ enable	R/W	1
4	Bck3LV_IRQ	Buck3 output voltage equal 66% x V <sub>Target</sub> , IRQ enable	R/W	1
3	Bck4LV_IRQ	Buck4 output voltage equal 66% x V <sub>Target</sub> , IRQ enable	R/W	1
2	PWRONSP_IRQ	PWRON short press, IRQ enable (32μs deglitch time)	R/W	0
1	PWRONLP_IRQ	PWRON long press, IRQ enable (32μs deglitch time)	R/W	0
0	SYSLV_IRQ	VIN voltage is lower than VOFF, IRQ enable	R/W	0

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Bit         Name         Description         Read/Write         Reset Value           7         OT         Internal over-temperature         R         0           6         Bck1LV         Buck1 output voltage equal 66% x VTarget         R         0           5         Bck2LV         Buck2 output voltage equal 66% x VTarget         R         0           4         Bck3LV         Buck3 output voltage equal 66% x VTarget         R         0           3         Bck4LV         Buck4 output voltage equal 66% x VTarget         R         0           2         PWRONSP         PWRON short press (32µs deglitch time)         R         0           1         PWRONLP         PWRON long press (32µs deglitch time)         R         0           0         VINLV         VIN voltage is lower than VOFF         R         0           1         PWRONLP         PWRON press forced shutdown, IRQ enable         R         0           Address         2A         IRQ Enable2         Read/Write         Reset Value           6         PWRONP_IRQ         PWRON press forced shutdown, IRQ enable         R/W         0           6         PWRONF_IRQ         PWRON press falling edge, IRQ enable         R/W         0           6	Address	29	IRQ Status1		
7         OT         Internal over-temperature         R         0           6         Bck1LV         Buck1 output voltage equal 66% x V <sub>Target</sub> R         0           5         Bck2LV         Buck2 output voltage equal 66% x V <sub>Target</sub> R         0           4         Bck3LV         Buck3 output voltage equal 66% x V <sub>Target</sub> R         0           3         Bck4LV         Buck4 output voltage equal 66% x V <sub>Target</sub> R         0           2         PWRONSP         PWRON short press (32µs deglitch time)         R         0           1         PWRONLP         PWRON short press (32µs deglitch time)         R         0           1         PWRONLP         PWRON long press (32µs deglitch time)         R         0           0         VINLV         VIN voltage is lower than VOFF         R         0           Address         2A         IRQ Enable2         IRQ Enable2         IRQ Enable2           Bit         Name         Description         Read/Write         Reset Value           7         KPSHDN_IRQ         PWRON press rising edge, IRQ enable         R/W         0           [4:0]         Reserved         R         0000           Address         2B         IRQ Status2 </td <td></td> <td></td> <td></td> <td>Read/Write</td> <td>Reset Value</td>				Read/Write	Reset Value
6         Bck1LV         Buck1 output voltage equal 66% x V <sub>Target</sub> R         0           5         Bck2LV         Buck2 output voltage equal 66% x V <sub>Target</sub> R         0           4         Bck3LV         Buck3 output voltage equal 66% x V <sub>Target</sub> R         0           3         Bck4LV         Buck4 output voltage equal 66% x V <sub>Target</sub> R         0           2         PWRONSP         PWRON short press (32µs deglitch time)         R         0           1         PWRONLP         PWRON short press (32µs deglitch time)         R         0           0         VINLV         VIN voltage is lower than VOFF         R         0           Address         2A         IRQ Enable2         R           Bit         Name         Description         Read/Write         Reset Value           7         KPSHDN_IRQ         FWRON press falling edge, IRQ enable         R/W         0           4         PWRONF_IRQ         PWRON press falling edge, IRQ enable         R/W         0           4         Reserved         R         0000         Read/Write         Reset Value           8         IRQ Status2         Read/Write         Reset Value           9         Reparted         R	7		'	R	
4         Bck3LV         Buck3 output voltage equal 66% x V <sub>Target</sub> R         0           3         Bck4LV         Buck4 output voltage equal 66% x V <sub>Target</sub> R         0           2         PWRONSP         PWRON short press (32µs deglitch time)         R         0           1         PWRONLP         PWRON long press (32µs deglitch time)         R         0           0         VINLV         VIN voltage is lower than VOFF         R         0           Address         2A         IRQ Enable2         ReadWrite         Reset Value           7         KPSHDN_IRQ         Key-press forced shutdown, IRQ enable         R/W         1           6         PWRONR_IRQ         PWRON press rising edge, IRQ enable         R/W         0           5         PWRONF_IRQ         PWRON press falling edge, IRQ enable         R/W         0           4ddress         2B         IRQ Status2         R         0           Bit         Name         Description         Read/Write         Reset Value           7         KPSHDN         Key-press forced shutdown         R         0           8         IRQ Status2         Read/Write         Reset Value           9         Reset Value         Read/Write	6	Bck1LV	Buck1 output voltage equal 66% x V <sub>Target</sub>	R	0
3	5	Bck2LV	Buck2 output voltage equal 66% x V <sub>Target</sub>	R	0
2         PWRONSP         PWRON short press (32μs deglitch time)         R         0           1         PWRONLP         PWRON long press (32μs deglitch time)         R         0           0         VINLV         VIN voltage is lower than VOFF         R         0           Address         2A         IRQ Enable2         IRQ Enable2           Bit         Name         Description         Read/Write         Reset Value           7         KPSHDN_IRQ         Key-press forced shutdown, IRQ enable         R/W         0           6         PWRONF_IRQ         PWRON press rising edge, IRQ enable         R/W         0           5         PWRONF_IRQ         PWRON press falling edge, IRQ enable         R/W         0           4ddress         2B         IRQ Status2         IRQ Status2 </td <td>4</td> <td>Bck3LV</td> <td>Buck3 output voltage equal 66% x V<sub>Target</sub></td> <td>R</td> <td>0</td>	4	Bck3LV	Buck3 output voltage equal 66% x V <sub>Target</sub>	R	0
1         PWRONLP         PWRON long press (32µs deglitch time)         R         0           0         VINLV         VIN voltage is lower than VOFF         R         0           Address         2A         IRQ Enable2         IRQ Enable2           Bit         Name         Description         Read/Write         Reset Value           7         KPSHDN_IRQ         Key-press forced shutdown, IRQ enable         R/W         0           6         PWRONE_IRQ         PWRON press rising edge, IRQ enable         R/W         0           5         PWRONF_IRQ         PWRON press falling edge, IRQ enable         R/W         0           4ddress         2B         IRQ Status2         <	3	Bck4LV	Buck4 output voltage equal 66% x V <sub>Target</sub>	R	0
0         VINLV         VIN voltage is lower than VOFF         R         0           Address         2A         IRQ Enable2         Bit         Name         Description         ReadWrite         Reset Value           7         KPSHDN_IRQ         Key-press forced shutdown, IRQ enable         R/W         1           6         PWRONR_IRQ         PWRON press rising edge, IRQ enable         R/W         0           5         PWRONF_IRQ         PWRON press falling edge, IRQ enable         R/W         0           [4:0]         Reserved         R         0000           Address         2B         IRQ Status2         R         0000           Bit         Name         Description         ReadWrite         Reset Value           7         KPSHDN         Key-press forced shutdown         R         0           6         PWRONR         PWRON press rising edge         R         0           5         PWRONF         PWRON press falling edge         R         0           [4:2]         Reserved         R         0           1         OTW125         Internal 125°C pre-warning over-temperature.         R         0           0         OTW100         Internal 100°C pre-warning over-temperature. <td>2</td> <td>PWRONSP</td> <td>PWRON short press (32µs deglitch time)</td> <td>R</td> <td>0</td>	2	PWRONSP	PWRON short press (32µs deglitch time)	R	0
Address         2A         IRQ Enable2           Bit         Name         Description         Read/Write         Reset Value           7         KPSHDN_IRQ         Key-press forced shutdown, IRQ enable         R/W         1           6         PWRONR_IRQ         PWRON press rising edge, IRQ enable         R/W         0           5         PWRONF_IRQ         PWRON press falling edge, IRQ enable         R/W         0           [4:0]         Reserved         R         0000           Address         2B         IRQ Status2         R         0000           Bit         Name         Description         Read/Write         Reset Value           7         KPSHDN         Key-press forced shutdown         R         0           6         PWRONR         PWRON press fising edge         R         0           5         PWRONF         PWRON press falling edge         R         0           [4:2]         Reserved         R         0           [4:2]         Reserved         R         0           1         OTW125         Internal 125°C pre-warning over-temperature.         R         0           Address         2C         PMU On/Off Sequence priority)         Read/Write	1	PWRONLP	PWRON long press (32μs deglitch time)	R	0
Bit         Name         Description         Read/Write         Reset Value           7         KPSHDN_IRQ         Key-press forced shutdown, IRQ enable         R/W         1           6         PWRONR_IRQ         PWRON press rising edge, IRQ enable         R/W         0           5         PWRONF_IRQ         PWRON press falling edge, IRQ enable         R/W         0           [4:0]         Reserved         R         0000           Address         2B         IRQ Status2           Bit         Name         Description         Read/Write         Reset Value           7         KPSHDN         Key-press forced shutdown         R         0           6         PWRONR         PWRON press rising edge         R         0           5         PWRONF         PWRON press falling edge         R         0           [4:2]         Reserved         R         0           1         OTW125         Internal 125°C pre-warning over-temperature.         R         0           0         OTW100         Internal 100°C pre-warning over-temperature.         R         0           Address         2C         PMU On/Off Sequence1         Read/Write         Reset Value           Bit         Name	0	VINLV	VIN voltage is lower than VOFF	R	0
7         KPSHDN_IRQ         Key-press forced shutdown, IRQ enable         R/W         1           6         PWRONR_IRQ         PWRON press rising edge, IRQ enable         R/W         0           5         PWRONF_IRQ         PWRON press falling edge, IRQ enable         R/W         0           [4:0]         Reserved         R         0000           Address         2B         IRQ Status2           Bit         Name         Description         Read/Write         Reset Value           7         KPSHDN         Key-press forced shutdown         R         0           6         PWRONR         PWRON press rising edge         R         0           5         PWRONF         PWRON press falling edge         R         0           [4:2]         Reserved         R         0           1         OTW125         Internal 125°C pre-warning over-temperature.         R         0           0         OTW100         Internal 100°C pre-warning over-temperature.         R         0           Address         2C         PMU On/Off Sequence1         Read/Write         Reset Value           Bit         Name         (0000 : off, 0001 : first on, 1100 : last on) (The sequence priority)         R/W         Option      <	Address	2A	IRQ Enable2		
6         PWRONR_IRQ         PWRON press rising edge, IRQ enable         R/W         0           5         PWRONF_IRQ         PWRON press falling edge, IRQ enable         R/W         0           [4:0]         Reserved         R         0000           Address         2B         IRQ Status2           Bit         Name         Description         Read/Write         Reset Value           7         KPSHDN         Key-press forced shutdown         R         0           6         PWRONR         PWRON press rising edge         R         0           5         PWRONF         PWRON press falling edge         R         0           [4:2]         Reserved         R         0           1         OTW125         Internal 125°C pre-warning over-temperature.         R         0           0         OTW100         Internal 125°C pre-warning over-temperature.         R         0           Address         2C         PMU On/Off Sequence1         Read/Write         Reset Value           Bit         Name         Description (Setting on/off sequence priority)         Read/Write         Reset Value           [7:4]         Buck2_Seq[3:0]         Setting Buck1 on/off sequence priority         R/W         Option	Bit	Name	Description	Read/Write	Reset Value
5         PWRONF_IRQ         PWRON press falling edge, IRQ enable         RW         0           [4:0]         Reserved         R         0000           Address         2B         IRQ Status2           Bit         Name         Description         Read/Write         Reset Value           7         KPSHDN         Key-press forced shutdown         R         0           6         PWRONR         PWRON press rising edge         R         0           5         PWRONF         PWRON press falling edge         R         0           [4:2]         Reserved         R         0           1         OTW125         Internal 125°C pre-warning over-temperature.         R         0           0         OTW100         Internal 100°C pre-warning over-temperature.         R         0           Address         2C         PMU On/Off Sequence1         Read/Write         Read/Write         Reset Value           Bit         Name         Description (Setting on/off sequence priority) (0000 : off, 0001 : first on, 1100 : last on)         Read/Write         Reset Value           [7:4]         Buck2_Seq[3:0]         Setting Buck1 on/off sequence priority         R/W         Option           Address         2D         PMU On/Off Sequenc	7	KPSHDN_IRQ	Key-press forced shutdown, IRQ enable	R/W	1
[4:0]         Reserved         R         0000           Address         2B         IRQ Status2           Bit         Name         Description         Read/Write         Reset Value           7         KPSHDN         Key-press forced shutdown         R         0           6         PWRONR         PWRON press rising edge         R         0           5         PWRONF         PWRON press falling edge         R         0           [4:2]         Reserved         R         0           1         OTW125         Internal 125°C pre-warning over-temperature.         R         0           0         OTW100         Internal 100°C pre-warning over-temperature.         R         0           Address         2C         PMU On/Off Sequence1         Read/Write         Read/Write         Reset Value           Bit         Name         Description (Setting on/off sequence priority)         R/W         Option           [7:4]         Buck2_Seq[3:0]         Setting Buck1 on/off sequence priority         R/W         Option           Address         2D         PMU On/Off Sequence priority         R/W         Option           Bit         Name         Description (Setting on/off sequence priority)         Read/Write	6	PWRONR_IRQ	PWRON press rising edge, IRQ enable	R/W	0
Address         2B         IRQ Status2           Bit         Name         Description         Read/Write         Reset Value           7         KPSHDN         Key-press forced shutdown         R         0           6         PWRONR         PWRON press rising edge         R         0           5         PWRONF         PWRON press falling edge         R         0           [4:2]         Reserved         R         000           1         OTW125         Internal 125°C pre-warning over-temperature.         R         0           0         OTW100         Internal 100°C pre-warning over-temperature.         R         0           Address         2C         PMU On/Off Sequence1         Read/Write         Read/Write         Reset Value           Bit         Name         Description (Setting on/off sequence priority)         Read/Write         Reset Value           [7:4]         Buck2_Seq[3:0]         Setting Buck1 on/off sequence priority         R/W         Option           [3:0]         Buck1_Seq[3:0]         Setting Buck1 on/off sequence priority         R/W         Option           Address         2D         PMU On/Off Sequence2         Description (Setting on/off sequence priority)         Read/Write         Reset Value </td <td>5</td> <td>PWRONF_IRQ</td> <td>PWRON press falling edge, IRQ enable</td> <td>R/W</td> <td>0</td>	5	PWRONF_IRQ	PWRON press falling edge, IRQ enable	R/W	0
Bit Name Description Read/Write Reset Value  7 KPSHDN Key-press forced shutdown R 0  6 PWRONR PWRON press rising edge R 0  5 PWRONF PWRON press falling edge R 0  [4:2] Reserved R 000  1 OTW125 Internal 125°C pre-warning over-temperature. R 0  0 OTW100 Internal 100°C pre-warning over-temperature. R 0  Address 2C PMU On/Off Sequence 1  Bit Name Description (Setting on/off sequence priority) (0000 : off, 0001 : first on, 1100 : last on) (The sequence is planed by first on last off)  [7:4] Buck2_Seq[3:0] Setting Buck2 on/off sequence priority R/W Option  [3:0] Buck1_Seq[3:0] Setting Buck1 on/off sequence 2  Description (Setting on/off sequence 2  Description (Setting on/off sequence 2  Description (Setting on/off sequence priority) (0000 : off, 0001 : first on, 1100 : last on)  PMU On/Off Sequence 2  Description (Setting on/off sequence priority) (0000 : off, 0001 : first on, 1100 : last on)  Read/Write Reset Value	[4:0]	Reserved		R	0000
7 KPSHDN Key-press forced shutdown R 0 6 PWRONR PWRON press rising edge R 0 5 PWRONF PWRON press falling edge R 0 [4:2] Reserved R 000 1 OTW125 Internal 125°C pre-warning over-temperature. R 0 0 OTW100 Internal 100°C pre-warning over-temperature. R 0 Address 2C PMU On/Off Sequence 1  Bit Name Description (Setting on/off sequence priority) (0000 : off, 0001 : first on, 1100 : last on) (The sequence is planed by first on last off) [7:4] Buck2_Seq[3:0] Setting Buck2 on/off sequence priority R/W Option [3:0] Buck1_Seq[3:0] Setting Buck1 on/off sequence priority R/W Option Address 2D PMU On/Off Sequence2  Description (Setting on/off sequence priority) (0000 : off, 0001 : first on, 1100 : last on) Read/Write Reset Value (0000 : off, 0001 : first on, 1100 : last on)	Address	2B	IRQ Status2		
6 PWRONR PWRON press rising edge R 0  5 PWRONF PWRON press falling edge R 0  [4:2] Reserved R 000  1 OTW125 Internal 125°C pre-warning over-temperature. R 0  0 OTW100 Internal 100°C pre-warning over-temperature. R 0  Address 2C PMU On/Off Sequence1  Bit Name Description (Setting on/off sequence priority) (0000: off, 0001: first on, 1100: last on) (The sequence is planed by first on last off)  [7:4] Buck2_Seq[3:0] Setting Buck2 on/off sequence priority R/W Option  [3:0] Buck1_Seq[3:0] Setting Buck1 on/off sequence priority R/W Option  Address 2D PMU On/Off Sequence2  Description (Setting on/off sequence priority) (0000: off, 0001: first on, 1100: last on) Read/Write Reset Value	Bit	Name	Description	Read/Write	Reset Value
5 PWRONF PWRON press falling edge R 0  [4:2] Reserved R 000  1 OTW125 Internal 125°C pre-warning over-temperature. R 0  O OTW100 Internal 100°C pre-warning over-temperature. R 0  Address 2C PMU On/Off Sequence 1  Bit Name Description (Setting on/off sequence priority) (0000 : off, 0001 : first on, 1100 : last on) (The sequence is planed by first on last off)  [7:4] Buck2_Seq[3:0] Setting Buck2 on/off sequence priority R/W Option  [3:0] Buck1_Seq[3:0] Setting Buck1 on/off sequence priority R/W Option  Address 2D PMU On/Off Sequence2  Description (Setting on/off sequence priority) (0000 : off, 0001 : first on, 1100 : last on) Read/Write Reset Value	7	KPSHDN	Key-press forced shutdown	R	0
[4:2] Reserved R 000  1 OTW125 Internal 125°C pre-warning over-temperature. R 0  O OTW100 Internal 100°C pre-warning over-temperature. R 0  Address 2C PMU On/Off Sequence1  Bit Name Description (Setting on/off sequence priority) (0000 : off, 0001 : first on, 1100 : last on) (The sequence is planed by first on last off)  [7:4] Buck2_Seq[3:0] Setting Buck2 on/off sequence priority R/W Option  [3:0] Buck1_Seq[3:0] Setting Buck1 on/off sequence priority R/W Option  Address 2D PMU On/Off Sequence2  Description (Setting on/off sequence priority) (0000 : off, 0001 : first on, 1100 : last on)  Read/Write Reset Value	6	PWRONR	PWRON press rising edge	R	0
1 OTW125 Internal 125°C pre-warning over-temperature. R 0 OTW100 Internal 100°C pre-warning over-temperature. R 0 Address 2C PMU On/Off Sequence1  Bit Name Description (Setting on/off sequence priority) (0000 : off, 0001 : first on, 1100 : last on) (The sequence is planed by first on last off)  [7:4] Buck2_Seq[3:0] Setting Buck2 on/off sequence priority R/W Option  [3:0] Buck1_Seq[3:0] Setting Buck1 on/off sequence priority R/W Option  Address 2D PMU On/Off Sequence2  Description (Setting on/off sequence priority) (0000 : off, 0001 : first on, 1100 : last on) Read/Write Reset Value	5	PWRONF	PWRON press falling edge	R	0
O OTW100 Internal 100°C pre-warning over-temperature. R  O Address 2C PMU On/Off Sequence1  Bit Name Description (Setting on/off sequence priority) (0000 : off, 0001 : first on, 1100 : last on) (The sequence is planed by first on last off)  [7:4] Buck2_Seq[3:0] Setting Buck2 on/off sequence priority R/W Option  [3:0] Buck1_Seq[3:0] Setting Buck1 on/off sequence priority R/W Option  Address 2D PMU On/Off Sequence2  Description (Setting on/off sequence priority) Read/Write Reset Value  Description (Setting on/off sequence priority) Read/Write Reset Value  O Name Description (Setting on/off sequence priority) R/W Option  Read/Write Reset Value  O Name Description (Setting on/off sequence priority) R/W Option  Read/Write Reset Value	[4:2]	Reserved		R	000
Address 2C PMU On/Off Sequence 1  Bit Name Description (Setting on/off sequence priority) (0000 : off, 0001 : first on, 1100 : last on) (The sequence is planed by first on last off)  [7:4] Buck2_Seq[3:0] Setting Buck2 on/off sequence priority R/W Option  [3:0] Buck1_Seq[3:0] Setting Buck1 on/off sequence priority R/W Option  Address 2D PMU On/Off Sequence2  Description (Setting on/off sequence priority) Read/Write Reset Value  Description (Setting on/off sequence priority) Read/Write Reset Value  Description (Setting on/off sequence priority) Read/Write Reset Value	1	OTW125	Internal 125°C pre-warning over-temperature.	R	0
Bit Name Description (Setting on/off sequence priority) (0000 : off, 0001 : first on, 1100 : last on) (The sequence is planed by first on last off)  [7:4] Buck2_Seq[3:0] Setting Buck2 on/off sequence priority R/W Option  [3:0] Buck1_Seq[3:0] Setting Buck1 on/off sequence priority R/W Option  Address 2D PMU On/Off Sequence2  Description (Setting on/off sequence priority) Read/Write Reset Value  Description (Setting on/off sequence priority) Read/Write Reset Value	0	OTW100	Internal 100°C pre-warning over-temperature.	R	0
Bit Name (0000 : off, 0001 : first on, 1100 : last on) (The sequence is planed by first on last off)  [7:4] Buck2_Seq[3:0] Setting Buck2 on/off sequence priority R/W Option  [3:0] Buck1_Seq[3:0] Setting Buck1 on/off sequence priority R/W Option  Address 2D PMU On/Off Sequence2  Description (Setting on/off sequence priority)  [3:0] Name (0000 : off, 0001 : first on, 1100 : last on) Read/Write Reset Value	Address	2C	PMU On/Off Sequence1		
[3:0] Buck1_Seq[3:0] Setting Buck1 on/off sequence priority R/W Option  Address 2D PMU On/Off Sequence2  Description (Setting on/off sequence priority) (0000 : off, 0001 : first on, 1100 : last on) Read/Write Reset Value	Bit	Name	(0000 : off, 0001 : first on, 1100 : last on)	Read/Write	Reset Value
Address 2D PMU On/Off Sequence2  Description (Setting on/off sequence priority) (0000 : off, 0001 : first on, 1100 : last on) Read/Write Reset Value	[7:4]	Buck2_Seq[3:0]	Setting Buck2 on/off sequence priority	R/W	Option
Description (Setting on/off sequence priority) Bit Name (0000 : off, 0001 : first on, 1100 : last on) Read/Write Reset Value	[3:0]	Buck1_Seq[3:0]	Setting Buck1 on/off sequence priority	R/W	Option
Bit Name (0000 : off, 0001 : first on, 1100 : last on) Read/Write Reset Value	Address	2D	PMU On/Off Sequence2		
(The sequence is planed by first on last oil)	Bit	Name		Read/Write	Reset Value
[7:4] Buck4_Seq[3:0] Setting Buck4 on/off sequence priority R/W Option	[7:4]	Buck4_Seq[3:0]	Setting Buck4 on/off sequence priority	R/W	Option
[3:0] Buck3_Seq[3:0] Setting Buck3 on/off sequence priority R/W Option	[3:0]	Buck3_Seq[3:0]	Setting Buck3 on/off sequence priority	R/W	Option



Address	2E	PMU On/Off Sequence3		
Bit	Name	Description (Setting on/off sequence priority) (0000 : off, 0001 : first on, 1100 : last on) (The sequence is planed by first on last off)	Read/Write	Reset Value
[7:4]	LDO2_Seq[3:0]	Setting LDO2 on/off sequence priority	R/W	Option
[3:0]	LDO1_Seq[3:0]	Setting LDO1 on/off sequence priority	R/W	Option
Address	2F	PMU On/Off Sequence4		
Bit	Name	Description (Setting on/off sequence priority) (0000 : off, 0001 : first on, 1100 : last on) (The sequence is planed by first on last off)	Read/Write	Reset Value
[7:4]	LDO4_Seq[3:0]	Setting LDO4 on/off sequence priority	R/W	Option
[3:0]	LDO3_Seq[3:0]	Setting LDO3 on/off sequence priority	R/W	Option
Address	30	PMU On/Off Sequence5		
Bit	Name	Description (Setting on/off sequence priority) (0000 : off, 0001 : first on, 1100 : last on) (The sequence is planed by first on last off)	Read/Write	Reset Value
[7:4]	LDO6_Seq[3:0]	Setting LDO6 on/off sequence priority	R/W	Option
[3:0]	LDO5_Seq[3:0]	Setting LDO5 on/off sequence priority	R/W	Option
Address	31	PMU On/Off Sequence5		
Bit	Name	Description (Setting on/off sequence priority) (0000 : off, 0001 : first on, 1100 : last on) (The sequence is planed by first on last off)	Read/Write	Reset Value
[7:4]	LDO8_Seq[3:0]	Setting LDO8 on/off sequence priority	R/W	Option
[3:0]	LDO7_Seq[3:0]	Setting LDO7 on/off sequence priority	R/W	Option
Address	32	Soft-Start Control		
Bit	Name	Description	Read/Write	Reset Value
[7:6]	Reserved		R	Option
[5:2]	Soft-Start End Control @ MASK_GPIO = 0 (External Enable pin define)	0000 : First turn on channel decide the PG_DLY time. 0001 : Buck1 decide the PG_DLY time 0100 : Buck1 decide the PG_DLY time. 0101 : LDO1 decide the PG_DLY time 1100 : LDO8 decide the PG_DLY time 1111 : LDO8 decide the PG_DLY time.	R/W	Option
[1:0]	Soft-Start Voltage level / time soft-start control.	Voltage Level 00 : When output voltage arrives to 80% VTarget, next channel will turn on. Soft-start time interval (TSS) : 01 : 1ms 10 : 4ms 11 : 8ms	R/W	Option

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Address	33	Buck Syn-Clock Control		
Bit	Name	Description	Read/Write	Reset Value
[7:6]	VCO_VRC	VCO input voltage slop. 00: 25mV/10μs, 01: 25mV/20μs 10: 25mV/40μs, 11: 25mV/80μs Note: The VCO's voltage input range is 0.375V to 1.8V and the output frequency is 500kHz to 2.18MHz.	R/W	Option
[5:0]	VCO_DVS	VCO input voltage DVS control 000000 : 0.375V (500kHz)  111001 : 1.8V (2MHz)  111111 : 1.8V (2MHz)	R/W	Option
Address	34	Buck Syn-Clock Spread Spectrum Control		
Bit	Name	Description	Read/Write	Reset Value
[7:1]	Reserved		R/W	0000000
0	SSOSC	Buck Clock Spread Spectrum Control 0: Disable spread spectrum function. 1: Turn on spread spectrum function.	R/W	Option
Address	3A	EEPROM (MTP) Control		
Bit	Name	Description	Read/Write	Reset Value
[7:6]	Reserved		R/W	00
5	MTP Page 2 Read	Read MTP Page 2	R	0
4	MTP Page 1 Read	Read MTP Page 1	R	0
[3:2]	Reserved		R/W	00
1	MTP Page 2 write	Write MTP Page 2, and MTP also needs to be logic high.	W	0
0	MTP Page 1 write	Write MTP Page 1, and MTP also needs to be logic high.	W	0



## Table 4. I<sup>2</sup>C to MTP Mapping Table MTP Page-1

I <sup>2</sup> C Rec	ister Address	Bit7	Disc		D.: 1				Bit0			
I <sup>2</sup> C Register Address		DIL										
	Function		BUCKcontrol1									
0.01	Meaning			Buck1Out	put[5:0]	R/W   A   Control2   R/W   A   Control3   R/W   A   Control4   R/W   A   Control4   R/W   A   Control5   R/W   A   Control5   R/W   A   Control6   R/W   A   Control7   R/W   A   Control7   R/W   A   Control7   R/W   A   Control7   Control7   R/W   A   Control7   Control7		Buck	1VRC			
0x01  0x02  0x03  0x04  0x06  0x07	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W			
	Reset Condition	Α	Α	Α	Α	Α	А	А	Α			
	Function				BUCKcon	trol2						
002	Meaning			Buck2Out	put[5:0]			Buck	2VRC			
UXU2	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	Buck: R/W A R/W A R/W A Reserved R/W A	R/W			
Function   BUCKco	А	Α	А	Α								
	Function		BUCKcontrol3									
000	Meaning		Buck3Output[5:0]									
UXU3	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W			
	Reset Condition	Α	A A		Α	А	А	Α	А			
	Function				BUCKcon	trol4						
0.04	Meaning		Buck4VRC									
0x04	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W			
	Reset Condition	А	Α	Α	Α	Α	Α		Α			
	Function	VRC Control										
0x05	Meaning				Buck4VRC _EN	Reserved	Reserved	Reserved	Reserved			
	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W			
	Reset Condition	Α	Α	Α	Α	Α	Α	R/W A Buck R/W A Buck R/W A Buck R/W A Buck R/W A  Buck R/W A  Reserved R/W A  Reserved R/W A  R/W A	Α			
	Function				Buck Mo	de						
0x06	Meaning					Buck1oms	Buck2oms	Buck3oms	Buck4oms			
	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W			
	Reset Condition	А	Α	Α	Α	А	Α	А	Α			
	Function				LDOcont	rol1						
0.07	Meaning	Reserved			LDC	)1OUT[6:0]						
0x07	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W			
	Reset Condition	А	Α	Α	Α	Α	Α	А	Α			
	Function				LDOcont	rol2						
0.700	Meaning	Reserved			LDC	)2OUT[6:0]		R/W A Buck: R/W A Buck: R/W A Buck: R/W A Buck: R/W A  Reserved R/W A  Buck: R/W A  Reserved R/W A  R/W A  Buck: R/W A				
0X08	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W			
	Reset Condition	А	Α	Α	Α	А	А	Buck3 R/W A  Buck4 R/W A  Reserved R/W A  Buck3oms R/W A  R/W A  R/W A  R/W A	Α			



I <sup>2</sup> C Reg	ister Address	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0		
	Function				LDOc	ontrol3					
OXO9  OXOB  OXOC  OXOC  OXOC	Meaning	Reserved		LDO3OUT[6:0]							
0X09	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W		
	Reset Condition	Α	А	А	Α	Α	Α	Α	Α		
	Function				LDOc	ontrol4					
0.00	Meaning	Reserved			L	DO4OUT[6:	0]	R/W A			
UXUA	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W		R/W		
	Reset Condition	А	Α	Α	Α	А	А	А	А		
	Function				LDOc	ontrol5					
OvOP	Meaning	Reserved		LDO5OUT[6:0]							
UXUB	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W		
	Reset Condition	Α	Α	А	А						
	Function	LDOcontrol6									
0,00	Meaning	Reserved	LDO6OUT[6:0]								
UXUC	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W		
	Reset Condition	Α	Α	Α	Α	А	Α	Α	А		
	Function	LDOcontrol7									
0×0D	Meaning	Reserved			L	DO7OUT[6:	0]				
OXOD	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W		
	Reset Condition	Α	Α	Α	Α	Α	Α	R/W A  R/W A  R/W A  R/W A  R/W A  R/W A  Reserved R/W A	Α		
	Function				LDOc	ontrol8					
0v0E	Meaning	Reserved			L	DO8OUT[6:	0]				
OXOL	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W		
	Reset Condition	Α	Α	Α	Α	Α	Α	Α	Α		
	Function			REBOC	T/PWRHOL	D delay time	e control				
0v10	Meaning	Delaye	d2[1:0]	Delaye	d1[1:0]	THO	OLD	Reserved	DisTHOLD		
0.10	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W		
	Reset Condition	Α	А	А	Α	А	А	Α	Α		
0x10	Function			VIN UVLO	update defa	ult value afte	er power on)	•			
0x12	Meaning	\	/OFF setting	9	Reserved	Reserved	Reserved	R/W A  Reserved R/W A  Reserved R/W A	Reserved		
0.1.2	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W		R/W		
	Reset Condition	Α	Α	Α	Α	В	В	В	В		



#### MTP Page-2

I <sup>2</sup> C Register Address		Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	
	Function			PWRON t	ime Parame	ters Setting / PG delay				
0.44	Meaning	START	_TIME	L_PRES	S_TIME	SHDN_	PRESS	PG_	DLY	
0x14  0x15  0x16  0x2C  0x2D  0x2F	Read/Write	R/W	R/W	R/W	R/W R/W		R/W	R/W	R/W	
	Reset Condition	А	А	А	А	А	А	PG_R/W A SHDN_PRESS_SHORT R/W A VINLV_ENSHDN R/W A Seq[3:0] R/W A Seq[3:0] R/W A Seq[3:0] R/W A	Α	
	Function				SHDN	Control				
0x15	Meaning	Reserved	SHDN_ TIMING	SHDN_0	DLYTIME	Reserved	SHDN_PRESS	PRESS_	PWRON_ NORMOFF _EN	
	Read/Write	R/W	R/W	R/W R/W		R/W	R/W	R/W	R/W	
0x15  0x16  0x2C  0x2D	Reset Condition	В	Α	А	А	А	А	А	А	
	Function			Power	ed Off condit	tions enable	setting			
0x16	Meaning	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved		VINLV_ SEQ_EN	
	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
	Reset Condition	А	А	Α	Α	Α	Α	Α	Α	
	Function	PMU On/Off Sequence1								
0.20	Meaning		Buck2_	Seq[3:0]		Buck1_Seq[3:0]				
UXZC	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	W R/W A A  DLY_ PRESS_ SHORT W R/W A A  Perved VINLV_ ENSHDN W R/W A A  UCk1_Seq[3:0] W R/W A A  DO1_Seq[3:0] W R/W A A  DO1_Seq[3:0] W R/W A A	R/W	
	Reset Condition	А	А	Α	Α	А	А	А	А	
	Function				PMU On/Off	f Sequence2				
0.42D	Meaning		Buck4_	Seq[3:0]			Buck3_	SHDN_ PV NC SHORT R/W A Seq[3:0] R/W		
UXZD	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
	Reset Condition	А	Α	Α	Α	А	Α	Α	Α	
	Function				PMU On/Off	Sequence3				
٥٠٠٥	Meaning		LDO2_	Seq[3:0]			LDO1_S	Seq[3:0]		
UXZE	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
	Reset Condition	А	А	А	А	А	Α	Α	Α	
	Function				PMU On/Off	f Sequence4				
٥٠٠٥	Meaning		LDO4_S	Seq[3:0]			LDO3_S	Seq[3:0]		
UX∠F	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	PG_ R/W A  SHDN_ PRESS_ SHORT  R/W A  VINLV_ ENSHDN  R/W A  Seq[3:0]  R/W A  Seq[3:0]  R/W A  Seq[3:0]  R/W A  Seq[3:0]  R/W A	R/W	
	Reset Condition	А	Α	А	А	A	А	А	А	



I <sup>2</sup> C Reg	jister Address	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	
	Function				Sequence5					
0.20	Meaning		PMU On/Off Sequence5           LDO6_Seq[3:0]         LDO5_Se           R/W         R/W         R/W         R/W         R/W           A         A         A         A         A         A           A         A         A         A         A         A         A         A           Br/W         R/W         R	Seq[3:0]						
0x30	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	Seq[3:0] R/W A Seq[3:0] R/W A Soft-Sta R/W A	R/W	
	Reset Condition	А	А	А	Α	Α	А	Α	Α	
	Function		PMU On/Off Sequence6							
0.24	Meaning		LDO8_S	Seq[3:0]			LDO7_	Seq[3:0]		
0x31	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
	Reset Condition	А	А	Α	А	Α	Α	Α	Α	
	Function	Soft-Start Control								
0x32	Meaning	Reversed	Reversed	eversed Soft-Start End Select @ MASK_GPIO = 1 Soft-Start Co						
0x32	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
	Reset Condition	Α	Α	Α	А	Α	А	А	Α	
	Function		Buck Syn-Clock Control							
0x33	Meaning	VCO_	_VRC			VCO_DVS				
UXSS	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
	Reset Condition	Α	Α	Α	А	Α	А	Α	Α	
	Function			Buck Sy	n-Clock Spre	ead Spectrur	n Control			
0x34	Meaning	Reversed	Reversed	Reversed	Reversed	Reversed	Reversed	Reversed	SSOSC	
UX34	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
	Reset Condition	А	А	А	А	А	А	А	Α	

#### **Reset Condition**

А	Reset by MTP (Register 0x12 VOFF Setting)					
В	Reset when VIN < 1.7V.					

#### Table 5. MTP Code Table

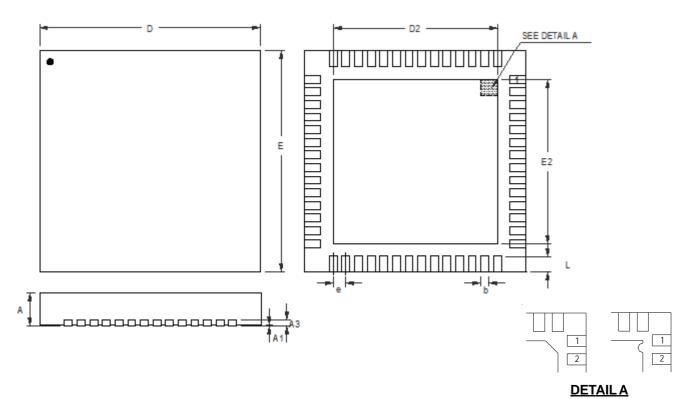
Product No.	RT5028FGQW	RT5028FGQW-06
Code No.	05	06
Register	MTP Value	MTP Value
0x01	В0	В0
0x02	40	50
0x03	1C	1C
0x04	D0	D0
0x05	5	5
0x06	4F	4F
0x07	16	16



Code No.	05	06
Register	MTP Value	MTP Value
0x08	8	8
0x09	8	8
0x0A	0C	0C
0x0B	0C	0C
0x0C	0C	0C
0x0D	44	24
0x0E	44	44
0x10	61	61
0x12	CF	CF
0x14	40	40
0x15	49	49
0x16	0E	0E
0x2C	64	74
0x2D	53	53
0x2E	42	42
0x2F	54	54
0x30	16	19
0x31	78	86
0x32	2E	2E
0x33	39	39
0x34	0	0



## **Outline Dimension**



Pin #1 ID and Tie Bar Mark Options

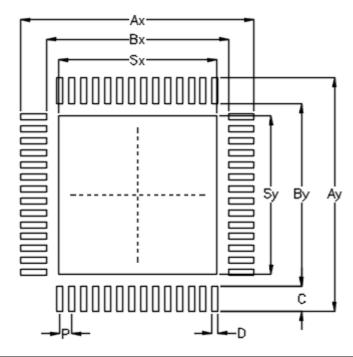
Note: The configuration of the Pin #1 identifier is optional, but must be located within the zone indicated.

Symbol	Dimensions	In Millimeters	Dimensions In Inches			
Symbol	Min	Max	Min	Max		
А	0.700	0.800	0.028	0.031		
A1	0.000	0.050	0.000	0.002		
A3	0.175	0.250	0.007	0.010		
b	0.150	0.250	0.006	0.010		
D	6.900	7.100	0.272	0.280		
D2	5.150	5.250	0.203	0.207		
Е	6.900	7.100	0.272	0.280		
E2	E2 5.150		0.203	0.207		
е	0.4	100	0.016			
L	0.350	0.450	0.014	0.018		

W-Type 56L QFN 7x7 Package



## **Footprint Information**



Package	Number of	Footprint Dimension (mm)								Tolerance	
r ackaye	Pin	Р	Ax	Ау	Вх	Ву	С	D	Sx	Sy	Tolerance
V/W/U/XQFN7*7-56	56	0.40	7.80	7.80	6.10	6.10	0.85	0.20	5.30	5.30	±0.05

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